## Model 7111-S-26589

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This packing list provides information for Keithley's Model 7111-S-26589. The Model 7111-S-26589 contains a 7111-S card, a 7011-C card, and a bracket. Review the following information before using the Model 7111-S-26589.

## KEITHLEY Safety Precautions

The following safety precautions should be observed before using this product and any associated instrumentation. Although some instruments and accessories would normally be used with non-hazardous voltages, there are situations where hazardous conditions may be present.
This product is intended for use by qualified personnel who recognize shock hazards and are familiar with the safety precautions required to avoid possible injury. Read and follow all installation, operation, and maintenance information carefully before using the product. Refer to the manual for complete product specifications.
If the product is used in a manner not specified, the protection provided by the product may be impaired.
The types of product users are:
Responsible body is the individual or group responsible for the use and maintenance of equipment, for ensuring that the equipment is operated within its specifications and operating limits, and for ensuring that operators are adequately trained.
Operators use the product for its intended function. They must be trained in electrical safety procedures and proper use of the instrument. They must be protected from electric shock and contact with hazardous live circuits.
Maintenance personnel perform routine procedures on the product to keep it operating properly, for example, setting the line voltage or replacing consumable materials. Maintenance procedures are described in the manual. The procedures explicitly state if the operator may perform them. Otherwise, they should be performed only by service personnel.
Service personnel are trained to work on live circuits, and perform safe installations and repairs of products. Only properly trained service personnel may perform installation and service procedures.
Keithley products are designed for use with electrical signals that are rated Installation Category I and Installation Category II, as described in the International Electrotechnical Commission (IEC) Standard IEC 60664. Most measurement, control, and data I/O signals are Installation Category I and must not be directly connected to mains voltage or to voltage sources with high transient over-voltages. Installation Category II connections require protection for high transient over-voltages often associated with local AC mains connections. Assume all measurement, control, and data I/O connections are for connection to Category I sources unless otherwise marked or described in the Manual.
Exercise extreme caution when a shock hazard is present. Lethal voltage may be present on cable connector jacks or test fixtures. The American National Standards Institute (ANSI) states that a shock hazard exists when voltage levels greater than 30V RMS, 42.4 V peak, or 60 VDC are present. A good safety practice is to expect that hazardous voltage is present in any unknown circuit before measuring.

Operators of this product must be protected from electric shock at all times. The responsible body must ensure that operators are prevented access and/or insulated from every connection point. In some cases, connections must be exposed to potential human contact. Product operators in these circumstances must be trained to protect themselves from the risk of electric shock. If the circuit is capable of operating at or above 1000 volts, no conductive part of the circuit may be exposed.
Do not connect switching cards directly to unlimited power circuits. They are intended to be used with impedance limited sources. NEVER connect switching cards directly to AC mains. When connecting sources to switching cards, install protective devices to limit fault current and voltage to the card.
Before operating an instrument, make sure the line cord is connected to a properly grounded power receptacle. Inspect the connecting cables, test leads, and jumpers for possible wear, cracks, or breaks before each use.
When installing equipment where access to the main power cord is restricted, such as rack mounting, a separate main input power disconnect device must be provided, in close proximity to the equipment and within easy reach of the operator.
For maximum safety, do not touch the product, test cables, or any other instruments while power is applied to the circuit under test. ALWAYS remove power from the entire test system and discharge any capacitors before: connecting or disconnecting cables or jumpers, installing or removing switching cards, or making internal changes, such as installing or removing jumpers.

Do not touch any object that could provide a current path to the common side of the circuit under test or power line (earth) ground. Always make measurements with dry hands while standing on a dry, insulated surface capable of withstanding the voltage being measured.
The instrument and accessories must be used in accordance with its specifications and operating instructions or the safety of the equipment may be impaired.
Do not exceed the maximum signal levels of the instruments and accessories, as defined in the specifications and operating information, and as shown on the instrument or test fixture panels, or switching card.
When fuses are used in a product, replace with same type and rating for continued protection against fire hazard.
Chassis connections must only be used as shield connections for measuring circuits, NOT as safety earth ground connections.
If you are using a test fixture, keep the lid closed while power is applied to the device under test. Safe operation requires the use of a lid interlock.

If a $\xlongequal{\perp}$ screw is present, connect it to safety earth ground using the wire recommended in the user documentation.

The $\angle$ symbol on an instrument indicates that the user should refer to the operating instructions located in the manual.

The symbol on an instrument shows that it can source or measure 1000 volts or more, including the combined effect of normal and common mode voltages. Use standard safety precautions to avoid personal contact with these voltages.
The WARNING heading in a manual explains dangers that might result in personal injury or death. Always read the associated information very carefully before performing the indicated procedure.
The CAUTION heading in a manual explains hazards that could damage the instrument. Such damage may invalidate the warranty.

Instrumentation and accessories shall not be connected to humans.
Before performing any maintenance, disconnect the line cord and all test cables.

To maintain protection from electric shock and fire, replacement components in mains circuits, including the power transformer, test leads, and input jacks, must be purchased from Keithley Instruments. Standard fuses, with applicable national safety approvals, may be used if the rating and type are the same. Other components that are not safety related may be purchased from other suppliers as long as they are equivalent to the original component. (Note that selected parts should be purchased only through Keithley Instruments to maintain accuracy and functionality of the product.) If you are unsure about the applicability of a replacement component, call a Keithley Instruments office for information.
To clean an instrument, use a damp cloth or mild, water based cleaner. Clean the exterior of the instrument only. Do not apply cleaner directly to the instrument or allow liquids to enter or spill on the instrument. Products that consist of a circuit board with no case or chassis (e.g., data acquisition board for installation into a computer) should never require cleaning if handled according to instructions. If the board becomes contaminated and operation is affected, the board should be returned to the factory for proper cleaning/servicing.

The following information is for the use of the Model 7111-S relay card with the screw terminal card replaced by a 96-pin connector card.
The pin numbers for the four banks are shown in Figure 2 through 5.
Note that the contact potential is increased to less than 1 microvolt due to the addition of the 96-pin connector.
Also, keep in mind that pins 1 and 33 must be jumpered to close the four output relays on the connector card.

The Model 7111-S is a low-voltage, quad $1 \times 10$, single-pole form C multiplexer card. (A second pole is normally not used but is available if needed.) The Model 7111-S assembly consists of a screw terminal connector card and a relay card. External test circuits are wired directly to the screw terminals of the connector card. Also available from Keithley is the Model 7011-ST. This is an extra screw terminal connector card, which can be used to wire a second test system without disturbing the wiring of the first test system.

Some key features of the 7111-S card include:

- Low contact potential and offset current for minimal effect on low-level signals.
- The connector card detaches from the relay card allowing easy access to the screw terminals and jumpers.
- Easy jumper configuration of one, two, three or four multiplexer banks.
- Backplane jumpers - Cutting jumpers disconnects multiplexer bank outputs from the Models 7001/7002 analog backplane.

The Model 7111-S is a form C version of Keithley's 7011-S, which is a quad $1 \times 10$, two-pole form A multiplexer card.
The cards have similar operating and servicing characteristics. Refer to the Model 7011-S and 7011-C Instruction Manual (Keithley part number 7011-901-00) for details.

Figure 1 shows a simplified schematic of the 7111-S card.
Figure 1
Model 7111-S simplified schematic


NOTE: O ne of four banks shown. The LO input is normally not used but it is available if needed as shown.

Figure 2
Bank A schematic

## 7111-S

BANK A


Notes: 1. Pins 9 and 41 are the shield of 7011-MTC-(*) cable assembly.
2. Pins 1 and 33 must be jumpered to allow the output relays on the connector card to close. This is provided in the 7011-M TC-(*).

Figure 3
Bank B schematic

7111-S BANK B


Figure 4
Bank C schematic


Figure 4
Bank D schematic

7111-S
BANK D


## Models 7011-C and 7011-S

Quad $1 \times 10$ Multiplexer Cards

Refer to the following pages for information on the Model 7011-C that is used as part of the Model 7111-S-26589.

## 7011 SPECIFICATIONS

MODEL 7011-S Quad $1 \times 10$ Multiplexer with Screw Terminals.
MODEL 7011-C Quad $1 \times 10$ Multiplexer with Mass Terminated Connector. MULTIPLEX CONFIGURATION: Four independent $1 \times 102$-pole Multiplex banks or two independent $1 \times 104$-pole Multiplex banks. Adjacent banks can be connected together. Jumpers can be removed to isolate any bank from the backplane.
CONTACT CONFIGURATION: 2-pole Form A (Hi, Lo).
CONNECTOR TYPE:
7011-S: Screw terminal, \#16AWG maximum wire size, with .092 inch O.D. 28 Conductors maximum. \#22AWG typical wire size with .062 inch O.D. 88 Conductor maximum.
7011-C: 96-Pin male Euro card connector. Mates to female twisted wire cable, crimp or solder connector.

## MAXIMUM SIGNAL LEVEL.

DC Signals: 110 V DC between any two pins, 1 A switched. 30VA (resistive load).
AC Signals: 125 V RMS or 175 V AC peak, between any two pins, 1 A switched, 60 VA (resistive load).
COMMON MODE VOLTAGE: 175 V peak, any pin to chassis.

## CONTACT LIFE:

Cold Switching: $10^{8}$ closures.
At Maximum Signal Levels: $10^{5}$ closures.
CHANNEL RESISTANCE (per conductor): $<1 \Omega$

CONTACT POTENTIAL:
7011-S: $<500 \mathrm{nV}$ per contact pair (Hi, Lo).
$<1.5 \mu \mathrm{~V}$ per single contact.
7011-C: $<1.5 \mu \mathrm{~V}$ per contact pair ( Hi , Lo) (typically $<1 \mu \mathrm{~V}$ ). $<3.5 \mu \mathrm{~V}$ per single contact (typically $<3 \mu \mathrm{~V}$ ).
OFFSET CURRENT: < 100 pA .
ACTUATION TIME: 3 ms .
ISOLATION:
Bank $>10^{9} \Omega,<25 \mathrm{pF}$.
Channel to Channel: $>10^{9} \Omega,<50 \mathrm{pF}$.
Differential: Configured as $1 \times 10>10^{\circ} \Omega,<100 \mathrm{pF}$. Configured as $1 \times 40>10^{9} \Omega,<200 \mathrm{pF}$.
Common Mode: Configured as $1 \times 10>10^{9} \Omega,<200 \mathrm{pF}$.
Configured as $1 \times 40>10^{\circ} \Omega,<600 \mathrm{pF}$.
CROSS TALK ( $1 \mathrm{MHz}, 50 \Omega$ Load):
Bank <-40 dB.
Channel: $<-40 \mathrm{~dB}$.
INSERTION LOSS ( $50 \Omega$ Source, 50 Load): $<0.1 \mathrm{~dB}$ below $1 \mathrm{MHz},<3 \mathrm{~dB}$ below 2 MHzz .
RELAY DRIVE CURRENT (per relay): 16 mA .
ENVIRONMENT:
Operation: $0^{\circ} \mathrm{C}$ to $50^{\circ} \mathrm{C}$, up to $35^{\circ} \mathrm{C}<80 \% \mathrm{RH}$.
Storage: $\quad-25^{\circ} \mathrm{C}$ to $65^{\circ} \mathrm{C}$
Specifications subject to change without notice.

7011 Quad $1 \times 10$ Multiplexer


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# General Information 

### 1.1 Introduction

This section contains general information about the Model 7011 Quad $1 \times 10$ Multiplexer card.

There are two basic versions of this multiplexer card; the Model 7011-S and the Model 7011-C. The Model 7011-S assembly consists of a screw terminal connector card and a relay card. External test circuits are wired directly to the screw terminals of the connector card. Also available from Keithley is the Model 7011-ST. This is an extra screw terminal connector card. With an extra connector card, you can wire a second test system without disturbing the wiring configuration of the first test system.

The Model 7011-C assembly consists of a multi-pin (mass termination) connector card and the relay card. External test circuit connections to the multiplexer are made via the 96 -pin male DIN connector on the connector card. Keithley offers a variety of optional accessories that can be used to make connections to the connector card (see paragraph 1.9).

The rest of Section 1 is arranged in the following manner:

### 1.2 Features

### 1.3 Warranty information

### 1.4 Manual addenda

1.5 Safety symbols and terms
1.6 Specifications
1.7 Unpacking and inspection
1.8 Repacking for shipment
1.9 Optional accessories

### 1.2 Features

The Model 7011 is a low voltage, two-pole, quad, $1 \times 10$ multiplexer card. Some of the key features include:

- Low contact potential and offset current for minimal effects on low-level signals.
- The connector board detaches from the relay board allowing easy access to the screw terminals (Model 7011-S) and jumpers.
- Easy jumper configuration of one, two, three or four multiplexer banks.
- Backplane jumpers. Cutting jumpers disconnects multiplexer bank outputs from the Model 7001 analog backplane.


### 1.3 Warranty information

Warranty information is located on the inside front cover of this instruction manual. Should your Model 7011 require warranty service, contact the Keithley representative or authorized repair facility in your area for further information. When returning the multiplexer card for repair, be sure to fill out and include the service form at the back of this manual in order to provide the repair facility with the necessary information.

### 1.4 Manual addenda

Any improvements or changes concerning the multiplexer card or manual will be explained in an addendum included with the card. Addenda are provided in a page replacement format. Simply replace the obsolete pages with the new pages.

### 1.5 Safety symbols and terms

The following symbols and terms may be found on an instrument or used in this manual.

The symbol on an instrument indicates that the user should refer to the operating instructions located in the instruction manual.

The symbol on an instrument shows : nigh voltage may be present on the terminal(s). Lse standard safety precautions to avoid personal contact with these voltages.

The WARNING heading used in this manual explains dangers that might result in personal injury or death. Always read the associated information very carefully before performing the indicated procedure.

The CAUTION heading used in this manual explains hazards that could damage the multiplexer card. Such damage may invalidate the warranty.

### 1.6 Specifications

Model 7011 specifications are found at the front of this manual. These specifications are exclusive of the multiplexer mainframe specifications.

### 1.7 Unpacking and inspection

### 1.7.1 Inspection for damage

The Model 7011 is packaged in a re-sealable, anti-static bag to protect it from damage due to static discharge and from contamination that could degrade its performance. Before removing the card from the bag, observe the following precautions on handling.

## Handling Precautions:

1. Always grasp the card by the side edges and shields. Do not touch the board surfaces or components.
2. When not installed in a Model 7001 mainframe, keep the card in the anti-static bag and store it in the original packing carton.

After removing the card from its anti-static bag, inspect it for any obvious signs of physical damage. Report any such damage to the shipping agent immediately.

### 1.7.2 Shipping contents

The following items are included with every Model 7011 order:

- Model 7011 Quad $1 \times 10$ Multiplexer Card
- Model 7011 Instruction Manual
- Additional accessories as ordered


### 1.7.3 Instruction manual

The Model 7011 Instruction Manual is three-hole drilled so that it can be added to the three-ring binder of the Model 7001 Instruction Manual. After removing the plastic wrapping, place the manual in the binder following the mainframe instruction manual. Note that a manual identification tab is included and should precede the multiplexer card instruction manual.

If an additional instruction manual is required, order the manual package, Keithley part number 7011-90100 . The manual package includes an instruction manual and any pertinent addenda.

### 1.7.4 Repacking for shipment

Should it become necessary to return the Model 7011 for repair, carefully pack the unit in its original packing carton or the equivalent, and include the following information:

- Advise as to the warranty status of the multiplexer card.
- Write ATTENTION REPAIR DEPARTMENT on the shipping label.
- Fill out and include the service form located at the back of this manual.


### 1.8 Optional accessories

The following accessories are available for use with the Model 7011:

Model 7011-ST - This screw terminal connector card is identical to the one provided with the Model 7011-S assembly. An extra screw terminal connector card allows you to wire a second test system without disturbing the wiring configuration of the first connector card.

Model 7011-KIT-R - This connection kit includes a 96 -pin female DIN connector that will mate directly to the connector on the Model 7011-C or to a standard 96pin male DIN bulkhead connector (see Model 7011MTR). This connector uses solder cups for connections to external circuitry. It includes an adapter for a round cable and the housing.

Model 7011-MTC-2 - This 2-meter round cable assembly is terminated with a 96 -pin female DIN connector on each end. It will mate directly to the connector on the Model 7011-C and to a standard 96 -pin male DIN bulkhead connector (see Model 7011-MTR).

Model 7011-MTR - This 96-pin male DIN bulkhead connector uses solder cups for connections to external circuitry. It will mate to the Model 7011-KTT-R connector, and Model 7011-MTC-2 cable assembly.

## 2

## Multiplexing Basics

### 2.1 Introduction

This section covers the basics for multiplex switching and is arranged as follows:
2.2 Basic multiplex configurations: Covers the basic multiplex configurations; quad $1 \times 10$ configuration, dual $1 \times 20$ configuration and single $1 \times 40$ configuration. The significance of the backplane jumpers is also covered here.
2.3 Typical multiplex switching schemes: Explains some of the basic ways a multiplexer can be used to source or measure. Covers single-ended switching, differential (floating) switching and sensing.

24 System expansion: Discusses the various configurations that are possible by using multiple cards.

### 2.2 Basic multiplexer configurations

A simplified schematic of the Model 7011 multiplexer is shown in Figure 2-1. It is organized as four $1 \times 10$ multiplexer banks. Each bank has 10 inputs and one output. Two-pole switching is provided for each multiplexer input, with HI and LO switched. Two or more banks can be jumpered together to expand multiplexer inputs, and backplane jumpers provide bank connections to a second card installed in Model 7001 mainframe.


Note: Factory Configuration shown

Figure 2-1
Model 7011 simplified schematic

### 2.2.1 Multiplexer bank-to-bank jumpers

Jumpers are installed on the connector card to connect multiplexer banks together to form a multiplexer of $1 \times$ 40. Each jum: - - set connects two adjacent banks together. These junper sets are included with the Model 7011.

The bank-to-bank jumpers allow you to configure the multiplexer card in a variety of ways. Typical multiplexer configurations include:

- Four $1 \times 10$ roultiplexers; no jumpers installed (Figure 2-2).
- Two $1 \times 20$ multiplexers; Bank A jumpered to Bank B, Bank C jumpered to Bank D (Figure 2-3).
- One $1 \times 40$ multiplexer; all bank-to-bank jumpers installed (Figure 2-4).

Other combinations are possible, including multiplexers of various sizes (in multiples of 10 channels). For example, you could install jumpers to configure the card as one $1 \times 30$ and one $1 \times 10$ multiplexer.

Refer to Section 3 for information on installing bank-tobank jumpers.


Figure 2-2
Four $1 \times 10$ multiplexer configuration (jumpers not installed)


Figure 2-3
Two $1 \times 20$ multiplexer configuration (jumpers installed)


Figure 2-4
One $1 \times 40$ multiplexer configuration (jumpers installed)

### 2.2.2 Backplane jumpers

There are four pairs of backplane jumpers located on the relay card. With the jumpers installed, the banks of the multiplexer card are connected to the analog backplane of the Model 7001 allowing expansion with a second 7001 card installed in the mainframe. With the jumpers removed (cut), the multiplexer card is isolated from another card installed in the mainframe.

The three-pole analog backplane of the Model 7001 mainframe is shown in Figure 2-5. Through this analog backplane the banks of a Model 7011 multiplexer card, installed in one slot, can be connected to the banks (or rows) of a compatible card installed in the other slot of the mainframe.

Model 7001


Figure 2-5
Model 7001 analog backplane

Figure 2-6 shows how each bank of the Model 7011 is connected to the backplane. Notice that since the Model 7011 is a two-pole card, there is no connection made to the Guard terminal of the backplane. The Model 7011 is shipped from the factory with the backplane jumpers installed.

Removing (cutting) the backplane jumpers isolates the card from the backplane, and subsequently, any card installed in the other slot. For information on removing the jumpers, refer to Section 3.

## NOTE

The Model 7001 does not provide an analog backplane for the non-701X series cards. As a result, any of these cards installed in one slot in the mainframe is electrically isolated from any card installed in the other slot. The only way to connect a Model 7011 to one of these cards is to wire them together.


Figure 2-6
Bank connections to backplane

### 2.3 Typical multiplexer switching schemes

The following paragraphs describe some basic switching schemes that are possible with a two-pole switching multiplexer. These switching schemes include some various shielding configurations to help minimize noise pick up in sensitive measurement applications. These shields are shown connected to chassis ground. For some test configurations, shielding may prove to be more effective connected to circuit common. Chassis ground is accessible at the rear panel of the Model 7001.

### 2.3.1 Single-ended switching

In the single-ended switching configuration, the source or measure instrument is connected to the DUT through a single pathway as shown in Figure 2-7. The instrument is connected to the output of one of the banks and the DUT is shown connected to one of the inputs for that bank.

### 2.3.2 Differential switching

The differential or floating switching configuration is shown in Figure 2-8. The advantage of using this configuration is that the terminals of the source or measure instrument are not confined to the same pathway. Each terminal of the instrument can be switched to any available input in the test system.


Figure 2-7
Single-ended switching example


Figure 2-8
Differential switching example

### 2.3.3 Sensing

- 

Figure 2-9 shows how the multiplexer card can be configured to use instruments that have sensing capability. The main advantage of using sensing is to cancel the effects of switch card path resistance ( $<1 \Omega$ ) and the resistance of external cabling. Whenever path resistance is a consideration, sensing should be used.

### 2.3.4 SMU connections

Figure 2-10 shows how to connect a Keithley Model 236,237 or 238 Source Measure Unit to the multiplexer card. By using triax cables that are unterminated at one end, the driven guard and chassis ground are physically extended all the way to the card.


Figure 2-9
Sensing example


WARNING: Hazardous voltages may be present on GUARD. Make sure all cable shields are properly insulated before applying power.

Figure 2-10
SMU connections

### 2.4 Multiplexer expansion

With the use of additional switching cards and mainframes, larger systems can be configured. Each Model 7001 Switch System mainframe will accommodate up to two cards, and up to six mainframes can be connected together. Thus, a switch system using as many as 12 cards can be configured.

### 2.4.1 Two-card switching systems

Each Model 7001 Switch System mainframe can accommodate two cards to allow the following switching configurations.

## Separate switching systems

Two singie-card systems can be configured by removing the backplane jumpers from one of the cards. The
two cards will be controlled by the same mainframe, but they will be electrically isolated from each other. Figure 2-11 shows an example using two Model 7011 multiplexer cards.

## Multiplexer input expansion

You can double the number of multiplexer inputs by simply installing two "as shipped" Model 7011s in the Model 7001 mainframe. By leaving the backplane jumpers installed, the banks of the multiplexer card installed in slot 1 (CARD 1) are automatically connected to the banks of the multiplexer card installed in slot 2 (CARD 2) through the analog backplane.

Figure 2-12 shows an example of input expansion. Each Model 7011 card is configured as four $1 \times 10$ multiplexers. By connecting the banks together (via Model 7001 analog backplane), the resultant multiplexer system has 20 inputs for each of the four banks. Notice that if all the bank-to-bank jumpers (for bath cards) were installed, the result would be a single $1 \times 80 \mathrm{mul}-$ tiplexer.


Figure 2-11
Two separate multiplexer systems


Figure 2-12
Multiplexer input expansion example

## Mixing card types

Different types of cards can be used together to create some unique switching systems. For example, you could have a Model 7011 multiplexer card installed in one slot and a Model 7012 matrix card installed in the other slot.

Figure 2-13 shows a possible switching system using a matrix card and a multiplexer card. The backplane jumpers for both the matrix and muitiplexer cards must be installed. This allows matrix rows to be connected to multiplexer banks. On the multiplexer card, the bank-to-bank jumpers must be removed to main-
tain isolation between matrix rows. See the instruction manual for the Model 7012 for complete information on the matrix card.

### 2.4.2 Mainframe multiplexer expansion

Multiplexer systems using up to 12 multiplexer cards are possible by using six Model 7001 mainframes together. Each Model 7011 added to the system provides 40 additional inputs. Paragraph 3.4.3 explains how to connect a test system using two mainframes.


Notes: 1. Modets 7011 and 7012 backplane jumpers must be installed.
2. Modet 7011 bank-to-bank jumpers must be removed.

Figure 2-13
Mixed card type example

# Card Connections \& Installation 

### 3.1 Introduction

## WARNING

The procedures in this section are intended only for qualified service personnel. Do not perform these procedures unless qualified to do so. Failure to recognize and observe normal safety precautions could result in personal injury or death.

The information in this section is arranged as follows:
3.2 Handling precautions: Explains precautions that must be followed to prevent contamination to the multiplexer card assembly. Contamination could degrade the performance of the multiplexer card.
3.3 Commections: Covers the basics for connecting external circuitry to the two available connector cards for the multiplexer; the screw terminal connector card and the multi-pin connector card.
3.4 Typical connection schemes: Provides some typical connection schemes for single card, two-card and two-mainframe system configurations.
3.5 Model 7011 installation: Provides a procedure to install the multiplexer card assembly in the Model 7001 mainframe.

### 3.2 Handling precautions

To maintain high impedance isolation, care should be taken when handling the relay card to avoid contamination from such foreign materials as body oils. Such contamination can substantially lower leakage resistances, thus degrading performance.

To avoid possible contamination, always grasp the relay and connector cards by the side edges or shields. Do not touch the board surfaces or components. On connectors, do not touch areas adjacent to the electrical contacts. Dirt build-up over a period of time is another possible source of contamination. To avoid this problem, operate the mainframe and multiplexer card in a clean environment.

If a card becomes contaminated, it should be thoroughly cleaned as explained in paragraph 5.2.

### 3.3 Connections

This paragraph provides the basic information needed to connect your external test circuitry to the multiplexer. It includes the installation of the bank-to-bank jumpers on the connector card, installation/removal of backplane jumpers on the relay card, and detailed in-
formation on making external connections to the two available connector cards.

## WARNING

The following connection information is intended to be used by qualified service personnel. Failure to recognize and observe standard safety precautions could result in personal injury or death.


### 3.3.1 Bank-to-bank jumpers

As explained in paragraph 2.2.1, the banks of the multiplexer card can be connected together (using plug-in jumpers) to form larger multiplexers. The locations of the bank-to-bank jumper terminals for both connector cards are shown in Figure 3-1.

B. Multi-pin Connector Card

Figure 3-1
Bank-to-bank jumper locations

Terminal identification is provided by Figure 3-2. On the drawing, the six terminal pairs are labeled W100 through W105. The top three terminal pairs (W101, W103 and W105) are used to connect the LO terminals of the banks together. The bottom terminal pairs (W100, W102 and W104) are used to connect the HI terminals of the banks together. Table 3-1 summarizes the effects of each jumper.


Figure 3-2
Bank-to-bank jumper terminal identification

Table 3-1
Bank-to-bank jumpers (refer to Figure 3-2)

| Installed <br> jumper | Effect |
| :---: | :--- |
| W101 | Connect Bank A LO to Bank B LO |
| W100 | Connect Bank A HI to Bank B HI |
| W103 | Connect Bank B LO to Bank C LO |
| W102 | Connect Bank B HI to Bank C HI |
| W105 | Connect Bank C LO to Bank D LO |
| W104 | Connect Bank C HI to Bank D HI |

Referring to Figure 3-1 for jumper locations, perform the following steps to install bank-to-bank jumpers:

1. If mated together, separate the relay card from the connector card by removing the mounting screw and pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
2. Refer to Figure 3-2 and Table 3-1 to determine which jumpers to install.
3. Using Figure 3-3 as a guide, install the jumpers on the appropriate terminal pairs.


Figure 3-3
Bank-to-bank jumper installation

### 3.3.2 Backplane jumpers

The Model 7001 mainframe has an analog backplane that allows the banks of a Model 7011 multiplexer to be internally connected to a compatible switching card installed in the other slot (see paragraph 2.4.1 for details).

The backplane jumpers for the multiplexer card assembly are located on the relay card as shown in Figure 3-4. The card is shipped from the factory with the jumpers installed.

## Jumper removal

Perform the following steps to remove backplane jumpers:

1. If mated together, separate the relay card from the connector card by removing the mounting screw and pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
2. Use Figure 3-4 to locate the jumper(s) that are to be removed.
3. It is not necessary to physically remove the jumpers from the PC board. Using a pair of wire cutters, cut one lead of each jumper.

## :umper installation

Referring to Figure 3 -4 for jumper locations, perform the following steps to install backplane row jumpers:

1. If mated together, separate the relay card from the connector card by removing the mounting screw and pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
2. Physically remove a cut jumper by unsoldering it from the PC board.
3. Install a new \#22 AWG jumper wire (Keithley P/N $\mathrm{J}-15$ ) and solder it to the PC board.
4. Remove the solder flux from the PC board The cleaning procedure is explained in paragraph 5.2.


Figure 3-4
Backplane jumpers

### 3.3.3 Screw terminal connector card

The screw terminal connector card is shown in Figure $3-5$. Connections are made directly to the screw terminals of the twelve terminal blocks. Each screw terminal will accommodate \#16-22 AWG wire.


Figure 3-5
Model 7011 screw terminal connector card

## Wiring procedure

Perform the following procedure to wire circuitry to the screw terminal connector card:

## WARNING

Make sure all power is off and any stored energy in external circuitry is discharged.

1. If mated together, separate the connector card from the relay card by removing the mounting screw and pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
2. Using an insulated screwdriver, connect the circuitry to the appropriate terminals. Figure 3-6 shows how the output of Bank $A$ would be connected to a DMM.
3. Referring to Figure 3-7, remove the top half of the cable clamp as follows:
A. Loosen the cable clamp screw enough to disengage it from the bottom half of the cable clamp.
B. Using your thumb and forefinger, press the retaining clips inward and, with your other hand, remove the top half of the clamp.
4. Route wires under wire guide/connector shim.
5. Route the wires through the bottom half of the cable clamp.
6. Replace the top half of the clamp. It simply snaps onto the bottom half of the clamp. Tighten the cable clamp screw. The clamp serves as a strain relief for terminal block wires.
7. Mate the connector card to the relay card. The Model 7011 is now ready to be installed in the Model 7001 mainframe. See paragraph 3.5 for details.


Figure 3-6
Typical screw terminal connections


Figure 3-7
Cable clamp for screw terminal connector card

### 3.3.4 Multi-pin (mass termination) connector card

Since connections to external circuitry are made at the 96 -pin male DIN bulkhead connector, there is no need to separate the connector card from the relay card. If the connector card is separated from the relay card, carefully mate them together and install the supplied 4-40 mounting screw. Make sure to handle the cards by the edges and shields to avoid contamination.

Terminal identification for the DIN connector of the multi-pin connector card is provided by Figure 3-8. This connector will mate to a 96 -pin female DIN connector.

Keithley has a variety of cable and connector accessories available to accommodate connections from the
connector card to test instrumentation and DUT (devices under test). In general, these accessories, which are summarized in Table 3-2, utilize a round cable assembly for connections.

Table 3-2
Mass termination accessories

| Model | Description |
| :--- | :--- |
| 7011-KIT-R | 96-pin female DIN connector and <br> housing for round cable. |
| 7011-MTC-2 | Two-meter round cable assembly <br> terminated with a 96-pin female <br> DIN connector on each end. |
| 7011-MTR | 96-pin male DIN bulkhead con- <br> nector. |

Pins of the Model 7011-C mass termination connector can be identified in one of three ways:

1. Mux terminal, consisting of banks $A-D$ and inputs 1-10.
2. Connector description, consisting of rows a-c and columns 1-32.
3. Schematic and component layout designation (1-96).

The following pinout diagrams show the correspondence between these arrangements:


View from pin side of connector

| Mux <br> Terminal |  | Desig. <br> 1a-32c | Schem. Desig. 1-96 | Mux Terminal |  | Connector Desig. 12-32c | Schem. Desig. 1-96 | $\begin{aligned} & \text { Mux } \\ & \text { Terminal } \end{aligned}$ |  | Connector Desig. 12-32c | Schem. Desig. 1-96 | Mux <br> Terminal |  | Connector Desig. 12-32c | Schem. Desig. 1-96 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Bank A |  |  |  | Bank B |  |  |  | Bank C |  |  |  | Bank D |  |  |  |
| Input 1 | HI | 32 c | 96 | Input 1 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 24 c \\ & 24 b \end{aligned}$ | 8856 | Input 1 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | 16 c | 80 | Input 1 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 8 c \\ & 8 b \end{aligned}$ | 7240 |
|  | LO | 32 b | 64 |  |  |  |  |  |  | 16 b | 48 |  |  |  |  |
| Input 2 | HI | 32a | 32 | Input 2 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 24 a \\ & 23 c \end{aligned}$ | $\begin{aligned} & 24 \\ & 87 \end{aligned}$ | input 2 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 16 a \\ & 15 c \end{aligned}$ | $\begin{aligned} & 16 \\ & 79 \end{aligned}$ | Input 2 |  | $\begin{aligned} & 8 \mathrm{a} \\ & 7 \mathrm{c} \end{aligned}$ | 871 |
|  | 10 | 31 c | 95 |  |  |  |  |  |  |  |  |  |  |  |  |
| input 3 | HI | 31 b | 63 | Input 3 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 23 \mathrm{~b} \\ & 23 \mathrm{a} \end{aligned}$ | $\begin{aligned} & 55 \\ & 23 \end{aligned}$ | Input 3 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 15 b \\ & 15 a \end{aligned}$ | 4715 | Input 3 |  | 7b | 397 |
|  | 10 | 31a | 31 |  |  |  |  |  |  |  |  |  |  |  |  |
| Input 4 | HI | 30 c | 94 | Input 4 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 22 \mathrm{c} \\ & 22 \mathrm{~b} \end{aligned}$ | 86 | Input 4 | $\begin{aligned} & \mathrm{Hi} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 14 c \\ & 14 b \end{aligned}$ | 7846 | Input 4 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $6 c$6 b | 7038 |
|  | LO | 30 b | 62 |  |  |  |  |  |  |  |  |  |  |  |  |
| Input 5 | HI | 30 a | 30 | Input 5 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 22 \mathrm{a} \\ & 21 \mathrm{c} \end{aligned}$ | $\begin{aligned} & 22 \\ & 85 \end{aligned}$ | Input 5 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 14 a \\ & 13 c \end{aligned}$ | 1477 | Input 5 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $6 a$$5 c$ | 669 |
|  | 1.0 | 29 c | 93 |  |  |  |  |  |  |  |  |  |  |  |  |
| Input 6 | HI | 29 b | 61 | Input 6 | $\begin{aligned} & \text { HI } \\ & \text { LO } \end{aligned}$ | $\begin{aligned} & 21 b \\ & 21 a \end{aligned}$ | 53 | Input 6 | HILO | $\begin{aligned} & 13 b \\ & 13 a \end{aligned}$ | 4513 | Input 6 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $5 b$$5 a$ | 375 |
|  | LO | 29a | 2.9 |  |  |  |  |  |  |  |  |  |  |  |  |
| Input 7 | HI | 28 c | 92 | Input 7 | $\begin{aligned} & \text { HI } \\ & \text { LO } \end{aligned}$ | $\begin{aligned} & 20 \mathrm{c} \\ & 20 \mathrm{~b} \end{aligned}$ | $\begin{aligned} & 84 \\ & 52 \end{aligned}$ | Input 7 | H1 | $\begin{aligned} & 12 c \\ & 12 \mathrm{~b} \end{aligned}$ | 7644 | input 7 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $4 c$$4 b$ | $\begin{aligned} & 68 \\ & 36 \end{aligned}$ |
|  | 10 | 286 | 60 |  |  |  |  |  |  |  |  |  |  |  |  |
| inputs | HI | 28a | 28 | Input 8 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 20 \mathrm{a} \\ & 19 \mathrm{c} \end{aligned}$ | $\begin{aligned} & 20 \\ & 83 \end{aligned}$ | Input 8 | Hi | 12a | 1275 | Input 8 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | 4a | 467 |
|  | LO | 27c | 91 |  |  |  |  |  |  |  |  |  |  |  |  |
| input 9 | HI | 27b | 59 | Input 9 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 19 b \\ & 19 a \end{aligned}$ | $\begin{aligned} & 51 \\ & 19 \end{aligned}$ | Input 9 | $\begin{aligned} & \text { HI } \\ & \text { LO } \end{aligned}$ | $\begin{aligned} & 11 b \\ & 11 a \end{aligned}$ | 4311 | Input 9 | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | 3b | 353 |
|  | LO | 27a | 27 |  |  |  |  |  |  |  |  |  |  |  |  |
| Input 10 | H | 26 c | 90 | Input 10 | $\begin{aligned} & \text { HI } \\ & \text { LO } \end{aligned}$ | $\begin{aligned} & 18 c \\ & 18 b \end{aligned}$ | $\begin{aligned} & 82 \\ & 50 \end{aligned}$ | Input 10 | HI | $\begin{aligned} & 10 c \\ & 10 b \end{aligned}$ | $\begin{aligned} & 74 \\ & 42 \end{aligned}$ | Input 10 | HILO | $2 c$2 b | 66 |
|  | LO | 26b | 58 |  |  |  |  |  |  |  |  |  |  |  |  |
| Output | HI | $26 a$ | 26 | Output | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 18 \mathrm{a} \\ & 17 \mathrm{c} \end{aligned}$ | 1881 | Output | $\begin{aligned} & \mathrm{HI} \\ & \mathrm{LO} \end{aligned}$ | $\begin{aligned} & 10 a \\ & 9 \mathrm{c} \end{aligned}$ | 1073 | Output | $\begin{aligned} & \mathrm{HI} \\ & 10 \end{aligned}$ | 2 a | 265 |
|  | 10 | 25 c | 89 |  |  |  |  |  |  |  |  |  |  | 1 c |  |

Notes: 1. Pins 9 a and 9 b (pins 9 and 41 on schematic) are shield.
2. Short pins 1 a to 1 b on the mating connector (pins 1 and 33 on schematic) to allow the output relays on the connector card to close.

Figure 3-8
Multi-pin card terminal identification

## Typical connection techniques

All external circuitry, such as instrumentation and DUTs, that you wish to connect to the multiplexer card must be terminated with a single 96 -pin female $D \mathbb{N}$ connector. The following connection techniques provide some guidelines and suggestions for wiring your circuitry

## WARNING

Before beginning any wiring procedures, make sure all power is off and any stored energy in external circuitry is discharged.

## NOTE

External circuitry should be connected ( 7 ed in) only with the 7001's power after the Model 7011 assembly is instailed in the Model 7001 mainframe. Installation is covered in paragraph 3.5.

Output relays-The multi-pin connector card uses a relay for each of the four output banks. These output relays are normally open to prevent any hazardous voltages (via the mainframe backplane) from appearing on the pins of the male DIN connector. The output relays will only close when the Model 7011-MTC-2 cable assembly is connected to card. If building you own cable assembly, you must make sure that it shorts pins la to 1 b of the card connector (Figure 3-8) when it is mated to the card. Shorting pins la to 1b allows the output relays to close.

Round cable assemblies - Figure 3-9 shows typical round cable connection techniques using accessories available from Keithley.

In Figure 3-9A, connections are accomplished using a Model 7011 MTC-2 cable and a Model 7011-MTR bulkhead connector. The two-meter round cable is terminated with a 96 -pin female DIN connector at each end. This cable mates directly to the multi-pin connector card and to the bulkhead connector. The bulkhead connector has solder cups to allow direct connection to instrumentation and DUT. Figure 3-10 provide: the pinout for the bulkhead connector.

In Figure 3-9B, connections are accomplished using a Model 7011 MTC-2 cable assembly that is cut in half. The 96 -pin female DIN connector on one end of the cable mates directly to the multi-pin connector card. The unterminated end of the cable is wired directly to instrumentation and DUT. The other half of the cable assembly could be used for a second switching card.

In Figure 3-9C, connections are accomplished using a custom-built cable assembly that consists of a Model 7011-KIT-R connector and a suitable round cable. Hitachi cable part number N2807-P/D-50TAB is a 50 -conductor cable. Two of these ci: jles can be used to supply 100 conductors.The connector has solder cups to accommodate the individual wires of the unterminated cable. Figure 3-11 provides an exploded view of the connector assembly and shows how the cable is connected. The connector end of the resultant cable assembly mates directly to the multi-pin connector card. The unterminated end of the cable assembly is wired directly to instrumentation and DUT.

B) $\begin{gathered}\text { Multi-Pin } \\ \text { Connector } \\ \text { Card }\end{gathered}$


Notes: Figure 3-11 provides an exploded view showing
how the connector (with cable) is assembled.
Cable Hitachi p/n N2807-P/D-50TAB is a 50 -conductor round cable. Two of these cables can be used to supply 100 conductors.

Figure 3-9
Typical round cable connection techniques


Note: See Figure 3-8 for terminal identification.

Figure 3-10
Model 7011-MTR connector pinout


Figure 3-11
Model 7011-KIT-R (with/cable) assembly

### 3.4 Typical connection schemes

The following information provides some typical connection schemes for single card, two-card and twomainframe system configurations. Connection schemes for the multi-pin connector card use some of the techniques presented in paragraph 3.3.2. Keep in mind that these are only examples to demonstrate various ways to wire a test system. Connection details for both connector cards (multi-pin and screw terminal cornector cards) are provided in paragraph 3.3.

### 3.4.1 Single card system

Figure 3-12 shows how external connections can be made to a single card system that uses the multi-pin connector card. This single card system is configured as two $1 \times 20$ multiplexers. To accomplish this, the appropriate bank-to-bank jumpers must be installed to connect Banks $A$ and $B$ together and Banks $C$ and $D$ together.

Instrumentation and DUTs are hard-wired to the Model 7011-MTR male bulkhead connector. This connector has solder cups that will accept wire size up to \#24 AWG. The test system is connected to the multiplexer
using the Model 7011-MTC-2 round cable assembly. This cable mates directly to both the external bulkhead connector and the Model 7011-C multiplexer card assembly. Notice that the bulkhead connector is shown mounted to a fixture to help keep the cabling stable during the test.

The single card system in Figure 3-13 is identical to the system in the previous illustration, except for the connection scheme. The system in Figure 3-13 uses the screw terminal connector card. With this card, single conductor connections are made directly from the terminal blocks of the connector card to instrumentation and DUTs.

When using a single card system, you will want to make sure that the card remains electrically isolated from any other switching cards. There are several ways to ensure isolation for a single card in the Model 7001 mainframe:

1. Vacate the other mainframe slot. If there is a Model 701 X card installed in the other slot, remove it.
2. Remove the backplane jumpers on the multiplexer card. This will disconnect the card from the analog backplane of the mainframe.
3. Remove the backplane jumpers from the switching card installed in the other slot.


Notes: Bank-to-Bank jumpers installed as follows:

Bank A connected to Bank B Bank C connected to Bank D

Simplified Equivalent Circuit
Figure 3-12
Single card system example (multi-pin connector card)


Notes: Bank-to-bank jumpers installed as follows:

Bank A connected to Bank B Bank C connected to Bank D

Simplified Equivalent Circuit

Figure 3-13
Single card system example (screw terminal connector card)

### 3.4.2 Two-card system

Both Figure 3-14 and Figure 3-15 show a system using two multiplexer cards installed in one Model 7001 mainframe to configure a single $1 \times 80$ multiplexer system. Each card is configured as a single $1 \times 40$ multiplexer. To accomplish this, all bank-to-bank jumpers (both cards) are installed to connect Banks A, B, C, and D together. By leaving the backplane jumpers of both cards installed, the banks of Card 1 are connected to the banks of Card 2 through the analog backplane of the Model 7001 mainframe resulting in the $1 \times 80$ configuration.

Figure 3-14 shows how external connections can be made for the multi-pin connector cards. In this example, a single Model 7011-MTC-2 round cable assembly is cut in half to provide two cables, each of which is unterminated at one end. The unterminated ends of the two cables are hard-wired to the instrument and DUT as shown in the drawing. The other ends of these cables mate directly to the Model 7011-C multiplexer card assemblies.

Figure 3-15 shows how external connections can be made for the screw terminal connector card. Single conductor connections are made directly from the screw terminals of the connector card to the instrument and DUT.

### 3.4.3 Two-mainframe system

Both Figure 3-16 and Figure 3-17 show a system using three multiplexer cards installed in two Model 7001 mainframes to configure a single $1 \times 120$ multiplexer
system. Each card is configured as a single $1 \times 40 \mathrm{mul}-$ tiplexer. To accomplish this, bank-to-bank jumpers of all three cards must be installed to connect Banks A, B, C , and D together.

By leaving the backplane jumpers of the cards in mainframe \#1 installed, the banks of Card 1 are connected to the banks of Card 2 through the analog backplane of the Model 7001 mainframe resulting in a $1 \times 80$ configuration. External bank connections from the instrument to the card in the second mainframe connect the banks of all three cards together to form the $1 \times 120$ multiplexer system. This system is similar to the Twocard System (see previous paragraph) except that a third multiplexer card (installed in a second mainframe) is added.

Figure 3-16 shows the connection scheme for the multipin connector cards. External circuit connections to the Model 7001 \#1 mainframe are identical to the ones used for the Two-card System. The third multiplexer card (installed in Model 7001 \#2 mainframe) shows how a custom-built cable can be used to make connections to external circuitry. A suitable round cable can be constructed using a 96 -pin female DIN connector (Model 7011-KTT-R) with two lengths of Hitachi cable P/N N2807-P/D-50TAB. This cable contains 50 conductors; two lengths provide 100 conductors. This cable will mate to the Model 7011-C multiplexer card assembly. The unterminated end of the cable is connected directly to the instrument and DUT. Notice that the bank connections for the third multiplexer card are made at the instruments.

Figure 3-17 shows connections for the screw terminal connector card. Single conductor connections are made directly from the screw terminals of the connector card to the instrument and DUT.


Single $1 \times 80$ Multiplexer

Simplified Equivalent Circuit

Figure 3-14
Two-card system example (multi-pin connector card)


Notes: 1. All bank-to-bank jumpers (both cards) must be installed
2. Backplane jumpers (both cards) must be installed.

Simplified Equivalent Circuit

Figure 3-15
Two-card system example (screw terminal connector card)


Figure 3-16
Two-mainframe system example (multi-pin connector card)


Simplified Equivalent Circuit

Figure 3-17
Two-mainframe system example (screw terminal connector card)

### 3.5 Model 7011 installation and removal

This paragraph explains how to install and remove the Model 7011 multiplexer card assembly from the Model 7001 mainframe.

## WARNING

Installation or removal of the Model 7011 is to be performed by qualified service personnel. Failure to recognize and observe standard safety precautions could result in personal injury or death.

## NOTE

If using the screw terminal connector card, make sure your external circuitry is wired to the card (as explained in paragraph 3.3.1) before installing the card assembly in the Model 7001 mainframe.

## CAUTION

To prevent contamination to the multiplexer card that could degrade performance, only handle the card assembly by the edges and shields.

## Multiplexer card installation

Perform the following steps to install the multiplexer card assembly in the Model 7001 mainframe:

## WARNING

Turn off power from all instrumentation (including the Model 7001 mainframe) and disconnect their line cords. Make sure all power is removed and any stored energy in external circuitry is discharged.

1. Mate the connector card to the relay card if they are separated. Install the supplied 4-40 screw at the end of the card to secure the assembly. Make sure to handle the cards by the edges and shields to prevent contamination.
2. Facing the rear panel of the Model 7001, select the slot (CARD 1 or CARD 2) that you wish to install the card in.
3. Referring to Figure 3-18 for Model 7011-C installafion, or Figure 3-19 for Model 7011-S installation, feed the multiplexer card assembly into the desired slot such that the edges of the relay card ride in the rails.
4. With the ejector arms in the unlocked position, push the card assembly all the way into the mainframe until the arms engage into the ejector cups. Then push both arms inward to lock the card into the mainframe.
5. For the 7011-C, also install the screw shown in Figure 3-18.

## Multiplexer card removal

To remove the multiplexer card assembly, first uniock it by pulling the latches outward, then pull the card assembly out of the mainframe. Remember to handle the card assembly by the edges and shields to avoid contamination that could degrade performance.


Figure 3-18
Model 7011-C card installation in Model 7001


Figure 3-19
7011-S card installation in Model 7001

## 4

## Operation

### 4.1 Introduction

The information in this section is formatted as follows:
4.2 Power limits: Summarizes the maximum power limits of the Model 7011 multiplexer card assembly.
4.3 Mainframe control of multiplexer card: Summarizes programming steps to control the multiplexer card from the Model 7001 Switch System mainframe.
4.4 Multiplexer switching examples: Provides some typical applications for using the Model 7011.
4.5 Measurement considerations: Reviews a number of considerations when using the Model 7011 to make measurements.

### 4.2 Power limits

## CAUTION

To prevent damage to the card, do not exceed the maximum signal level specifications of the card.

## Maximum signal levels

To prevent overheating or damage to the relays, never exceed the following maximum signal levels:

$$
\begin{array}{ll}
\text { DC signals: } & \begin{array}{l}
110 \mathrm{~V} \text { between any two pins (termi- } \\
\text { nals), } 1 \mathrm{~A} \text { switched, } 30 \mathrm{VA} \text { (resistive } \\
\text { load). }
\end{array} \\
\text { AC signals: } & \begin{array}{l}
125 \mathrm{~V} \text { rms or } 175 \mathrm{~V} \mathrm{AC} \mathrm{peak} \mathrm{be-} \\
\text { tween any two pins (terminals), } 1 \mathrm{~A}
\end{array} \\
& \text { switched, } 60 \mathrm{VA} \text { (resistive load) }
\end{array}
$$

### 4.3 Mainframe control of multiplexer card

The following information pertains to the Model 7011 multiplexer card. It assumes that you are familiar with the operation of the Model 7001 mainframe.

If you are not familiar with the operation of the mainframe, it is recommended that you proceed to Getting Started (Section 3) of the Model 7001 Instruction Manual after reading the following information.

### 4.3.1 Channel assignments

The Model 7001 has a channel status display (Figure 41) that provides the real-time state of each available channel. The left portion of the display is for slot 1 (Card 1), and the right portion is for slot 2 (Card 2).

Multiplexer organization of the channel status display for each slot is shown in Figure 4-2. The card contains 40 channels and is made up of four banks (Bank A, B, $C$, and D) of 10 multiplexer inputs as shown in the illustration.

To control the multiplexer (mux) card from the mainframe, each multiplexer input must have a unique

CHANNEL assignment which includes the slot number that the card is installed in. The CHANNEL assignments for the multiplexer card are provided in Figure 4-3. Each CHANNEL assignment is made up of the slot designator ( 1 or 2 ) and the multiplexer channel. To be consistent with Model 7001 operation, the slot designator and mux input are separated by exclamation points (!). Some examples of CHANNEL assignments are as follows:

CHANNEL $111=$ Slot 1 , Channel 1 (Input 1 of Bank A) CHANNEL $1!40=$ Slot 1, Channel 40 (Input 10 of Bank D)

CHANNEL 2!23 = Slot 2, Channel 23 (Input 3 of Bank C)

CHANNEL $2!36=$ Slot 2 , Input 36 (Input 6 of Bank D)

## CARD 2



- = Open Channel
num = Closed Channel

Figure 4-1
Channel status display


Figure 4-2
Display organization for multiplexer channels


Examples: $1118=$ Slot 1, Channel 18 (Input 8, Bank B) $2!36=$ Slot 2, Channel 36 (Input 6, Bank D)

Figure 4.3
Model 7011 programming channel assignments

### 4.3.2 Front panel control

## Closing and opening channels

A multiplexer channel is closed from the front panel by simply keying in the CHANNEL assignment and pressing CLOSE. For example, to close channel 36 (Input 6 of Bank D) of a multiplexer card installed in slot 2, key in the following channel list and press CLOSE:

SELECT CHANNELS $2!36$
The above closed channel can be opened by pressing OPEN or OPEN ALL. The OPEN key opens only the channels specified in the channel list, and OPEN ALL opens all channels.

The following display is an example of a channel list that consists of several channels:

SELECT CHANNELS $2!1,2!3,2!22-2!25$
Notice thet channel entries are separated by commas (). A corsela is inserted by pressing ENTER or the right cursor key $\triangleright$ ). The channel range is specified by using the hyphen (-) key .. separate the range limits. Pressing CLOSE will clc: : all the channels specified in the channe: list. Pressing OPEN (or OPEN ALL) will open the channels.

## Scanning channels

Multiplexer channels are scanned by creating a scan list and configuring the Model 7001 to perform a scan. The scan list is created in the same manner as a channel list (see Closing and Opening Channels). However, the scan list is specified from the "SCAN CHANNEL" display mode. )The SCAN LIST key toggles between the channel list and the scan list.) The following shows an example of a scan list:

SCAN CHANNELS $2!1,2!3,2!21-2!25$

When a scan is performed, the channels specified in the scan list will be scanned in the order that they are presented in the scan list.

A manual scan can be performed by using the RESET default conditions of the Model 7001. RESET is selected from the SAVESETUP menu of the main MENU. When RESET is performed, the mainframe is configured for an infinite number of manual scans. The first press of STEP takes the mainframe out of the idle state. The next press of STEP will close the first channel specified in the scan list. Each subsequent press of STEP will select the next channel in the scan list.

### 4.3.3 IEEE-488 bus operation

Bus operation is demonstrated using HP BASIC 4.0. The programming statements assume that the primary address of the mainframe is 07 .

## Closing and opening channels

The following SCPI commands are used to close and open channels:

> :CLOSe < list>
> :OPEN <list> | ALL

The following statement closes channels $1!1$, and $1!3$ through 1!11:

OUTPUT 707; ":clos (@1!1, 1!3:1!11)"

Notice that the colon (:) is used to separate the range limits.

Eit:- of the following statements will open channels 1!: . A $1!3$ through 1!11:

OUTPUT 707; ":open (@1!1, 1!3:1!11)"
OUTPUT 707; ":open all"

## Scanning channels

There are many commands associated with scanning. However, it is possible to configure a scan using as little as four commands. These commands are listed as follows:
*RST
:TRIGger:SEQuence:COUNt:AUTo ON"
:ROUTe:SCAN <list>
:INTT
:INTT

The first command resets the mainframe to a default scan configuration. The second command automatically sets the channel count to the number of channels in the Scan List, the third command defines the Scan List and the fourth command takes the Model 7001 out of the idle state.

The following program will perform a single scan through all 40 channels of a multiplexer card installed in slot 1 :

```
0 OUTPUT 707; "*RST"
20 OUTPUT 707; ":trig:seq:coun:auto on"
30 OUTPUT 707; ":scan (@ 111:1!40)"
40 OUTPUT 707; ":init"
50 END
```

Line 10 Selects a default configuration for the scan.
Line 20 Sets channel count to the scan-list-length.
Line 30 Defines the scan list.
Line 40 Take the Model 7001 out of the idle state. The scan is configured to start as soon as this command is executed.

When the above program is run, the scan will be completed in approximately 240 milliseconds ( 3 msec delay for each relay close and a 3 msec delay for each open), which is too fast to view from the front panel. An additional relay delay can be added to the program to slow down the scan for viewing. The program is modified by adding line 25 to slow down the scan. Also, Line 5 is added to the beginning of the program to ensure that all channels are open before the scan is started.

```
5 OUTPUT 707; ":open all"
10 OUTPUT 707; "*RST"
20 OUTPUT 707; ":trig:seq:coun:auto on"
25 OUTPUT 707; ":trig:del 0.25"
30 OUTPUT 707; ":scan (@ 1!1:1!40)"
40 OUTPUT 707; ":INIT"
50 END
```

Line 5 Opens all channels.
Line 25 Sets a $1 / 4$ second delay after each channel closes.

### 4.4 Multiplexer switching examples

This paragraph presents some typical applications for the Model 7011. These include resistor testing, transistor testing, and resistivity testing, which shows how to use the Model 7011 with a matrix card (Model 7012).

### 4.4.1 Resistor testing

The Model 7011 can be used to test a large number of resistors using only one test instrument or group of instruments. Such tests include two-wire and four-wire resistance measurements using a DMM, and low-resistance measurements using a current source and sensitive digital voltmeter, as discussed in the following paragraphs.

## Two-wire resistance tests

Figure 4-4 shows a typical test setup for making twowire resistance measurements. The Model 7011 card provides the switching function, while the resistance measurements are made by a Model 199 DMM. Since only two-pole switching is required for this application, one Model 7011 card can be used to switch up to 40 resistors (additional multiplexer banks can be added, if desired, by adding more cards).

Accuracy of measurements can be optimized by minimizing stray resistance.

Make connecting wires as short as possible to minimize path resistance. Another technique is to short one of the multiplexer inputs, close the shorted channel and then enable the DMM zero feature to cancel path resistance. Leave zero enabled for the entire test.

A. Test Configuration

B. Simplified Equivalent Circuit

Figure 4-4
2-wire resistance testing

## Four-wire resist: tests

More precise measurements over a wider range of system and DUT conditions can be obtained by using the four-wire measurement scheme shown in Figure 4-5. Here, separate sense leads from the Model 196 DMM are routed through the multiplexer to the resistor under test. The extra set of sense leads minimizes the effects of voltage drops across the test leads. Note, however, that an extra two poles of switching are required for each resistor tested. For this reason, only 20 resistors per card can be tested using this configuration.

The Model 7011 can be configured for 20 channels of 4pole operation by isolating Banks A and B from Banks $C$ and $D$, and by programming the Model 7001 mainframe for 4 -pole mode. The resulting paired channels are shown in Table 4-1.

Table 4-1
paired Channels in 4-pole Operation

| 7001 CHANNEL assignment | Channel pair in 4-pole | Connection designations |
| :---: | :---: | :---: |
| 1 | 1 and 21 | Bank A, In 1 and Bank C, In 1 |
| 2 | 2 and 22 | Bank $A, \operatorname{In} 2$ and Bank C, In 2 |
| 3 | 3 and 23 | Bank $A$, In 3 and Bank C, In 3 |
| 4 | 4 and 24 | Bank A, In 4 and Bank C, In 4 |
| 5 | 5 and 25 | Bank A, In 5 and Bank C, In 5 |
| 6 | 6 and 26 | Bank A, In 6 and Bank C, In o |
| 7 | 7 and 27 | Bank $A, \operatorname{In} 7$ and Bank C, In 7 |
| 8 | 8 and 28 | Bank A, In 8 and Bank C, In 8 |
| 9 | 9 and 29 | Bank A, In and Bank C, In |
| 10 | 10 and 30 | Bank A, In 10 and Bank C, In 10 |
| 11 | 11 and 31 | Bank B, In 1 and Bank D, In 1 |
| 12 | 12 and 32 | Bank B, In 2 and Bank D, In 2 |
| 13 | 13 and 33 | Bank B, In 3 and Bank D, In 3 |
| 14 | 14 and 34 | Bank B, In 4 and Bank D, In 4 |
| 15 | 15 and 35 | Bank B, In 5 and Bank D, In 5 |
| 16 | . 5 and 36 | Bank B, In 6 and Bank D, In 6 |
| 17 | 17 and 37 | Bank B, In 7 and Bank D, In 7 |
| 18 | 18 and 38 | Bank B, In 8 and Bank D, In 8 |
| 19 | 19 and 39 | Bank B, In 9 and Bank D, In 9 |
| 20 | 20 and 40 | Bank B, In 10 and Bank D, In 10 |

Bank jumper removal is described in paragraph 3.3.1. To configure the connector card for 4-pole operation, only remove the jumpers between Banks C and D (W102 and W103).

Selecting 4-pole operation for a Model 7001 card slot is discussed in Section 4 of the Model 7001 Instruction Manual. After the 4 -pole mode is selected, the Model 7001 mainframe will display just 20 channels for the chosen card slot. Each closed channel will also close its paired channel on the card.

Although the four-wire connection scheme minimizes problems caused by voltage drops, there is one other potentially troublesome area associated with low resistance measurements: thermal EMFs caused by the relay contacts. In order to compensate for thermal EMFs, the offset-compensated ohms feature of the Model 196 DMM should be used. To use this feature, short the HI and LO terminals of one of the bank inputs, then close the relay. Enable zero on the Model 196, then select off-set-compensated ohms.


Note: Jumpers between Banks $B$ and $C$ are removed.
A. Test Configuration

B. Simplified Equivalent Circuit

Figure 4-5
Four-wire resistance testing

## Low-level resistance measurements

Many times, it is necessary to make resistance measurements with either lower voltage sensitivity or higher currents than are available with ordinary DMMs. Examples of cases where low-level resistance measurements may be necessary include the testing of PC board traces, contacts, bus bars, and low resistance shunts.

Figure 4-6 shows a typical test configuration for a switching system capable of testing a number of low resistance devices. The Model 220 Current Source forces current through the device under test, while the Model 182 Sensitive Digital Voltmeter measures the resulting voltage across the device.
will have a detrimental effect on measurement accuracy unless steps are taken to avoid them (the Model 7011 has been designed to keep relay EMF at a minimal level.). Thermal EMF effects can be virtually eliminated by taking two voltage measurements, $\mathrm{E}_{1}$ and $\mathrm{E}_{2}$, the first with the current, I, flowing in one direction, and the second with a current, $I$, of the same magnitude flowing in the opposite direction. The resistance can then be calculated as follows:

$$
R=\frac{E_{2}-E_{1}}{2 I}
$$

Note that simply reversing the current source polarity will result in a $2 X$ accuracy specification change. To avoid this problem, matrix switching could be added to the test system to reverse the current. See paragraph 4.4.3.

Since low voltage levels are being measured, thermal EMF offsets generated by relay and connector contacts


Figure 4-6
Low resistance testing

### 4.4.2 Transistor testing

Typical transistor tests that can be performed with the aid of the Model 7011 include current gain tests, leakage tests, as well as tests to determine the commonemitter characteristics of the device. The following paragraphs discuss these tests and give typical equipment configurations for the tests.

## Current gain tests

The DC or static common-emitter current gain of a transistor can be determined by biasing the transistor for a specific value of base current, $I_{B}$, and then measuring the collector current, $I_{C}$. The $D C$ common-emitter current gain, $\beta$, of the transistor is then determined as follows:

$$
\beta=\frac{I_{C}}{I_{B}}
$$

Figure 4-7 shows the test configuration and equivalent circuit for the current gain test. The Model 224 Current Source is used to source the base current, $\mathrm{I}_{\mathrm{B}}$. The Model 230 Voltage Source supplies the collector-emitter voltage, $\mathrm{V}_{\mathrm{CE}}$, and the collector current, $\mathrm{I}_{\mathrm{C}}$, is measured by the Model 196 DMM. Switching among the transistors being tested is, of course, performed by the Model 7011 multiplexer card.

In order to perform the current gain test, the voltage source is first set to the desired value of $\mathrm{V}_{\mathrm{CE}}$. The current source is then set to a base current value that will result in the desired value of $I_{C}$ as measured by the DMM. The current gain can then be calculated as outlined above.

In order to reduce errors caused by voltage burden, use a higher current range on the Model 196 DMM. Doing so will result in the loss of one or two decades of resolution, but $3 \frac{1}{2}$ or $4 \frac{1}{2}$-digit resolution will probably be adequate for most situations.

A. Test Configuration

B. Simplified Equivalent Circuit

Figure 4-7
Configuration for current gain and common-emitter test

## Common-emitter characteristic tests

Common-emitter characteristics are determined by setting the base current, $I_{B}$, to specific values. At each $I_{B}$ value, the collector-emitter voltage, $\mathrm{V}_{\mathrm{CE}}$ is swept across the desired range at specific intervals, and the collector current, $I_{C}$ is then measured. When the data are plotted, the result is the familiar family of commonemitter curves (Figure 4-8).

The same test configuration that is used for current gain tests can be used for measuring common-emitter characteristics. The Model 224 is used to set the base current, $\mathrm{I}_{\mathrm{B}}$, to the desired values. The Model 230 Voltage Source provides the collector-emitter voltage, $\mathrm{V}_{\mathrm{CE}}$, and the Model 196 DMM measures the collector current, $I_{C}$.


### 4.4.3 Testing with matrix cards

The Model 7011 can be added to a matrix switching system to enhance the test capabilities of that system. The following paragraphs discuss an overall multiplexer/matrix switching system and also briefly outline a typical test that can be made with such a system.

## Multiplexer and matrix card connections

Figure 4-9 shows a typical system using Model 7012 and 7011 cards together. In this instance, the multiplexer card is configured as four $1 \times 10$ multiplexers. Note that rows of the matrix card are connected to the banks of the multiplexer card through the analog backplane of the mainframe; no external wiring is necessary to connect the two cards together.

In this application, the DUTs are connected to the bank inputs on the multiplexer card, allowing a large number of DUTs to be switched through the matrix card. Also, the instruments are connected to the columns on the matrix card. This particular configuration is best suited for applications requiring a large number of DUTs to be connected to several instruments. In other cases, the test configuration may call for a large number of instruments and few DUTs. In those situations, the instruments would be connected to the multiplexer inputs, and the DUTs would be connected to the columns.

Figure 4-8
Typical common-emitter characteristics


Note: The $70+1$ Bank-to-Bank
umpers must be removec.

Figure 4-9
Connecting multiplexer and matrix cards together

## Resistivity tests

The general test configuration shown in Figure 4-10 can be used to perform resistivity tests on semiconductors. Such tests can yield important information such as doping concentration.

As shown in Figure 4-10, the Model 7011 switches ten samples for the test. The Model 7012 Matrix card allows any device test node to be connected to any instrument terminal. The Model 220 Current Source
forces a current through the DUT, and the Model 196 DMM measures the voltage across the device. In order to minimize errors caused by sample loading, the Model 196 should be used on the 300 mV or 3 V ranges. Also, resistance values should be $1 \mathrm{M} \Omega$ or less.

In order to perform the tests, a current (from the Model 220 ) is applied to two terminals, and the voltage is measured (by the Model 196) across the two opposite terminals. A total of eight such measurements are required, as shown in Figure 4-11.

A. Connections

B. Simplified Equivalent Circuit (One measurement leg shown)

Figure 4-10
Resistivity test configuration


Figure 4-11
Measurement required for resistivity test

Once the measurements have been taken, the resistivity can be calculated. Two values of resistivity, A and B, are initially computed as follows:

$$
\begin{aligned}
& \sigma_{A}=\frac{1.1331 f_{A} t_{S}\left(V_{2}+V_{4}-V_{1}-V_{3}\right)}{I} \\
& \sigma_{B}=\frac{1.1331 f_{B} t_{S}\left(V_{6}+V_{8}-V_{5}-V_{7}\right)}{l}
\end{aligned}
$$

Where:
$\sigma_{\mathrm{A}}$ and $\sigma_{\mathrm{B}}$ are the resistivities in $\Omega-\mathrm{cm}$,
$\mathrm{t}_{\mathrm{S}}$ is the sample thickness in cm ,
$\mathrm{V}_{1}$ through $\mathrm{V}_{8}$ are the voltages measured by the Model 196,

I is the current through the sample in amperes,
$f_{A}$ and $f_{B}$ are geometrical factors based on sample symmetry ( $f_{A}=f_{B}=1$ ) for perfect symmetry.

Once $\sigma_{\mathrm{A}}$ and $\sigma_{\mathrm{B}}$ are known, the average resistivity, $\sigma_{\text {AVG }}$, can be determined as follows:

$$
\sigma_{A V G}=\frac{\sigma_{A}-\sigma_{B}}{2}
$$

### 4.5 Measurement considerations

Many measurements made with the Model 7011 are subject to vanous effects that can seriously affect lowlevel measurement accuracy. The following paragraphs discuss these effects and ways to minimize them.

### 4.5.1 Path isolation

The path isolation is simply the equivalent impedance between any two test paths in a measurement system. Ideally, the path isolation should be infinite, but the actual resistance and distributed capacitance of cables and connectors results in less than infinite path isolation values for these devices.

Path isolation resistance forms a signal path that is in parallel with the equivalent resistance of the DUT, as shown in Figure 4-12. For low-to-medium device resistance values, path isolation resistance is seldom a consideration; however, it can seriously degrade measurement accuracy when testing high-impedance devices. The voltage measured across such a device, for example, can be substantially attenuated by the voltage divider action of the device source resistance and path isolation resistance, as shown in Figure 4-13. Also, leakage currents can be generated through these resistances by voltage sources in the system.


$$
\begin{aligned}
\mathrm{R}_{\mathrm{DUT}} & =\text { Source Resistance of DUT } \\
E_{\text {DUT }} & =\text { Source EMF of DUT } \\
\mathrm{R}_{\text {PATH }} & =\text { Path Isolation Resistance } \\
\mathrm{R}_{\mathbb{N}} & =\text { Input Resistance of Measuring Instrument }
\end{aligned}
$$

Figure 4-12
Path isolation resistance


Figure 4-13
Voltage attenuation by path isolation resistance

Any differential isolation capacitance affects DC measurement settling time as well as AC measurement accuracy. Thus, it is often important that such capacitance be kept as low as possible. Although the distributed capacitance of the matrix card is generally fixed by design, there is one area where you do have control over the capacitance in your system; the connecting cables. To minimize capacitance, keep all cables as short as possible

### 4.5.2 Magnetic fields

When a conductor cuts through magnetic lines of force, a very small current is generated. This phenomenon will frequently cause unwanted signals to occur in the test leads of a switching matrix system. If the conductor has sufficient length, even weak magnetic fields like those of the earth can creat sufficient signals to affect low-level measurements.

Two ways to reduce these effects are: (1) reduce the lengths of the test leads, and (2) minimize the exposed circuit area. In extreme cases, magnetic shielding may be required. Special metal with high permeability at low flux densities (such as mu metal) is effective at reducing these effects.

Even when the conductor is stationary, magneticallyinduced signals may still be a problem. Fields can be
produced by various signals such as the $A C$ power line voltage. Large inductors such as power transformers can generate substantial magnetic fields, so care must be taken to keep the switching and measuring circuits a good distance away from these potential noise sources.

At high current levels, even a single conductor can generate significant fields. These effects can be minimized by using twisted pairs, which will cancel out most of the resulting fields.

### 4.5.3 Radio frequency interference

RFI (Radio Frequency Interference) is a general term used to describe electromagnetic interference over a wide range of frequencies across the spectrum. Such RFI can be particularly troublesome at low signal levels, but is can also affect measurements at high levels if the problem is of sufficient severity.

RFI can be caused by steady-state sources such as radio or TV signals, or some types of electronic equipment (microprocessors, high speed digital circuits, etc.), or it can result from impulse sources, as in the case of arcing in high-voltage environments. In either case, the effect on the measurement can be considerable if enough of the unwanted signal is present.

RFI can be minimized in several ways. The most obvious method is to keep the equipment and signal leads as far away from the RFI source as possible. Shielding the switching ard, signal leads, sources, and measuring instrumertis will often reduce RFI to an acceptable level. In extreme cases, a specially-constructed screen room may be required to sufficiently attenuate the troublesome signal.

Many instruments incorporate internal filtering that may help to reduce RFI effects in some situations. In some cases, additional external filtering may also be required. Keep in mind, however, that filtering may have detrimental effects on the desired signal.

### 4.5.4 Ground loops

When two or more instruments are connected together, care must be taken to avoid unwanted signals caused by ground loops. Ground loops usually occur when sensitive instrumentation is connected to other instrumentation with more than one signal return path such as power line ground. As shown in Figure 4-14, the resulting ground loop causes current to flow through the instrument LO signal leads and then back through power line ground. This circulating current develops a small but undesirable voltage between the LO terminals of the two instruments. This voltage will be added to the source voltage, affecting the accuracy of the measurement.


Figure 4-14
Power line ground loops

Figure $4-15$ shows how to connect several instruments together to eliminate this type of ground loop problem. Here, only one instrument is cornected to power line ground.


Figure 4-15
Eliminating ground loops

Ground loops are not normally a problem with instruments having isolated LO terminals. However, all instruments in the test setup may not be designed in this manner. When in doubt, consult the manual for all instrumentation in the test setup.

### 4.5.5 Keeping connectors clean

As is the case with any high-resistance device, the integrity of connectors can be damaged if they are not handled properly. If connector insulation becomes contaminated, the insulation resistance will be substantially reduced, affecting high-impedance measurement paths.

Oils and salts from the skin can contaminate connector insulators, reducing their resistance. Also, contaminants present in the air can be deposited on the insulator surface. To avoid these problems, never touch the connector insulating material. In addition, the multiplexer card should be used only in clean, dry environments to avoid contamination.

If the connector insulators should become contaminated, either by inadvertent touching, or from air-borne deposits, they can be cleaned with a cotton swab dipped in clean methanol. After thoroughly cleaning, they should be allowed to dry for several hours in a low-humidity environment before use, or they can be dried more quickly using dry nitrogen.

### 4.5.6 AC frequency response

The AC frequency response of the Model 7011 is important in test systems that switch AC signals. Refer to the specifications at the front of this manual.

## Service Information

## WARNING

The information in this section is intended only for qualified service personnel. Some of the procedures may expose you to hazardous voltages that could result in personal injury or death. Do not attempt to perform these procedures unless you are qualified to do so.

### 5.1 Introduction

This section contains information necessary to service the Model 7011 multiplexer card and is arranged as follows:
5.2 Handling and cleaning precautions: Discusses handling precautions and methods to clean the card should it become contaminated.
5.3 Performance verification: Covers the procedures necessary to determine if the card meets stated specifications.
5.4 Special handling of static-sensitive devices: Reviews precautions necessary when handling static-sensitive devices.
5.5 Principles of operation: Briefly discusses circuit operation
5.6 Troubleshooting: Presents some troubleshooting tips for the Model 7011 including relay replacement precautions.

### 5.2 Handling and cleaning precautions

Because of the high-impedance areas on the Model 7011, care should be taken when handling or servicing the card to prevent possible contamination. The following precautions should be taken when servicing the card.

Handle the card only by the edges and shields. Do not touch any board surfaces or components not associated with the repair. Do not touch areas adjacent to electrical contacts. When servicing the card, wear clean cotton gloves.

Do not store or operate the card in an environment where dust could settle on the circuit board. Use dry nitrogen gas to clean dust off the board if necessary.

Should it become necessary to use solder on the circuit board, use an OA-based (organic activated) flux. Remove the flux from the work areas when the repair has been completed. Use pure water along with clean cotton swabs or a clean soft brush to remove the flux. Take care not to spread the flux to other areas of the circuit
board. Once the flux has been removed, swab only the repaired area with methanol, then blow dry the board with dry nitrogen gas.

After cleaning, the card should be placed in a $50^{\circ} \mathrm{C}$ low hu:. dity environment for several hours before use.

### 5.3 Performance verification

The following paragraphs discuss performance verification procedures for the Model 7011, including path resistance, offset current, contact potential, and isolation.

With the Model 7011's backplane jumpers installed, the performance verification procedures must be performed with only one multiplexer card (the one being checked) installed in the Model 7001 mainframe. These conditions do not apply if the backplane jumpers are removed.

## CAUTION

Contamination will degrade the performance of the card. To avoid contamination, always grasp the card by
the side edges. Do not touch the connectors, and do not touch the board surfaces or components. On plugs and receptacles, do not touch areas adjacent to the electrical contacts.

## NOTE

Failure of any performance verification test may indicate that the multiplexer card is contaminated. See paragraph 5.2 to clean the card.

### 5.3.1 Environmental conditions

All verification measurements should be made at an ambient temperature between $18^{\circ}$ and $28^{\circ} \mathrm{C}$, and at a relative humidity of less than $70 \%$.

### 5.3.2 Recommended equipment

Table 5-1 summarizes the equipment necessary for performance verification, along with an application for each unit.

Table 5-1
Verification equipment

| Description | Model or part | Specifications | Applications |
| :--- | :--- | :--- | :--- |
| DMM | Keithley Model 196 | $300 \Omega ; 0.01 \%$ | Path resistance |
| Electrometer w/voltage source | Keithley Model 617 | $10 \mathrm{pA}, 100 \mathrm{pA} ;$ | Offset current, path isola- |
|  |  | $1.6 \% 100 \mathrm{~V}$ source; | $0.2 \%$ |
| Sensitive Digital Voltmeter |  |  |  |
| Triax cable (unterminated) | Keithley Model 182 | $3 \mathrm{mV} ; 60 \mathrm{ppm}$ | Contact potential |
| Low thermal cable | Keithley Model 7025 | - | Offset current |
| (unterminated) | Keithley Model 1484 | - | Contact potential |

### 5.3.3 Multiplexer card connections

The following information summarizes methods that can be used to connect test instrumentation to the two connector cards. Detailed connection information is provided in Section 3.

Model 7011-S - Instrumentation can simply be hardwired directly to the screw terminals of the connector card. Jumper wires should be kept as short as possible.

Model 7011-C-One method to make instrument connections to the multiplexer card is by hard-wiring a $96-$ pin female DIN connector then mating it to the connector on the Model 7011-C. Input and output shorting connections can also be done at the connector. The connector in the Model 7011-KIT-R connection kit (see Table 3-2) can be used for this purpose. Pin identification for the connector is provided by Figure 3-8.

## CAUTION

> After making solder connections to a connector, remove solder flux as explained in paragraph 5.2. Failure to clean the solder connections could result in degraded performance preventing the card from passing verification tests.

Before pre-wiring any connectors or plugs, study the following test procedures to fully understand the connection requirements.

### 5.3.4 Channel resistance tests

Perform the following steps to verify that each contact of every relay is closing properly and that the resistance is within specification.

1. Turn the Model 7001 off if it is on.
2. Turn on the Model 196, and allow it to warm up for one hour before making measurements.
3. Connect all input terminals of Bank A together to form one common terminal, as shown in Figure 51.
4. Set the Model 196 to the $300 \Omega$ range and connect the four test leads to the OHMS and OHMS SENSE input jacks.
5. Short the four test leads together and zero the Model 196. Leave zero enabled for the entire test.
6. Connect OHMS HI and OHMS SENSE FII of the Model 196 to the common terminal (jumper on Bank A inputs). It is recommended that the physical connections be made at inputs 1 and 10 of Bank A, as shown in Figure 5-1.
7. Connect OHMS LO and OHMS SENSE LO to the $\mathrm{HI}(\mathrm{H})$ terminal of Bank A .
8. Install the Model 7011 in slot 1 (CARD 1) of the Model 7001.
9. Turn on the Model 7001 and program it to close Channel 1!1 (Bank A, Input 1). Verify that the resistance of this path is $<1 \Omega$.
10. Open Channel $1!1$ and close Channel 1!2 (Bank A, Input 2). Verify that the resistance of this path is $<1 \Omega$.
11. Using the basic procedure in steps 9 and 10 , check the resistance of Bank A HI (H) terminal paths for Inputs 3 through 10 (Channels $1: 3$ through 1!10).
12. Turn off the Model 7001 and move the OHMS LO and OHMS SENSE LO test leads to the LO (L) terminal of Bank $A$.
13. Repeat steps 9 through 11 to check the LO (L) terminal paths of Bank A (Channels $1!1$ through 1!10).
14. Repeat the basic procedure in steps 1 through 13 for Banks B through D (Channels 1!11 through 1!40).


Figure 5-1
Path resistance test connections

### 5.3.5 Offset current tests

These tests check leakage current between $\mathrm{HI}(\mathrm{H})$ and LO (L) (differential offset current) and from $\mathrm{HI}(\mathrm{H})$ and LO (L) to chassis (common-mode offset current) of each pathway. In general, these tests are performed by simply measuring the leakage current with an electrometer. In the following procedure, the Model 617 is used to measure the leakage current. Test connections are shown in Figure 5-2.

Perform the following procedure to check offset current:

1. Turn the Model 7001 off if it is on, and remove any jumpers or wires connected to the multiplexer card.
2. Connect the triax cable to the Model 617, but do not connect it to the multiplexer card at this time.
3. Turn on the Model 617 and allow the unit to warm up for two hours before testing. After warm up, select the 200pA range, and enable zero check and zero correct in that order. Leave zero correct enabled for the entire procedure. Also, be certain that V- $\Omega$, GUARD is OFF and ground strap is connected to LO.
4. Connect the triax cable to Bank A HI and LO, as shown in Figure 5-2A.
5. Install the Model 7011 in slot 1 (CARD 1) of the Model 7001.
6. Turn on the Model 7001 and program the unit to close Channel 1!1 (Bank A, Input 1).
7. On the Model 617, disable zero check and allow the reading to settle. Verify that the reading is $<100 \mathrm{pA}$. This specification is the offset (leakage) current of the pathway.
8. Enable zero check on the Model 617 and open Channel 1!1 from the front panel of the Model 7001.
9. Repeat the basic procedure in steps 6 through 8 to check the rest of the pathways (Inputs 2 through 10) of Bank A (Channels 1!2 through 1!10).
10. Turn off the Model 7001 and change the electrometer connections to Bank B.
11. Repeat the basic procedure in steps 6 through 10 to check Bank B, Inputs 1 through 10 (Channels $1!11$ through 1!20).
12. Repeat the basic procedure in steps 6 through 11 for Banks C and D (Channels $1!21$ through 1!40).
13. Turn off the Model 7001 and change the electrometer connections, as shown in Figure 5-2B. Note that electrometer HI is connected to HI and LO of the Bank A output, which are jumpered together. Electrometer LO is connected to chassis.
14. Repeat steps 6 through 12 to check that the common mode offset current is $<100 \mathrm{pA}$.

A) Differential


Model 7011
B) Common-Mode

Figure 5-2
Differential offset current test connections

### 5.3.6 Contact potential tests

These tests check the EMF generated by each relay contact pair ( H and L ) for each pathway. The tests simply consist of using a sensitive digital voltmeter (Model 182) to measure the contact potential.

Perform the following procedure to check contact potential of each path:

1. Turn the Model 7001 off if it is on.
2. Place jumpers between Banks A-B, B-C, and C-D.
3. Turn on the Model 182 and allow the unit to warm up to achieve rated accuracy.
4. Place a short between HI to LO on each input (Channels 1-40).
5. Place a short between HI to LO on output Bank D (long enough to cut with wire cutters).
6. Connect the Model 182 input leads to HI and LO output Bank A using copper wires.
7. Install the Model 7011 in the Model 7001 slot 1, and turn the Model 7001 on.
8. Allow Models 7001,7011 and 182 to warm up for two hours.
9. Select the 3 mV range on the Model 182.
10. Press REL READING (on the Model 182) to null out internal offsets. Leave REL READING enabled for the entire procedure.
11. Turn the Model 7001 off. Remove the Model 7011 from slot 1. Cut the short on B and D output HI to LO.
12. Install the Model 7011 in the Model 7001 slot 1, and turn power on.
13. Wait 15 minutes.
14. Program the Model 7001 to close Channel $1!1$.
15. After settling, verify that reading on the Model 182 is $<500 \mathrm{nV}$ (for the Model 7011-S). This measurement represents the contact potential of the pathway.
16. From the Model 7001, open Channel $1!1$.
17. Repeat steps 12 through 14 for all 40 channels.


Figure 5-3
Contact potential test connections

### 5.3.7 Bank and channel-to-channel isolation tests

Bank isolation tests check the leakage resistance between adjacent banks. Channel-to-channel isolation tests check the leakage resistance between a Bank Output connection and a Bank Input connection with an adjacent Bank Input relay closed. In general, the tests are performed by applying a voltage ( 100 V ) across the leakage resistance and then measuring the current. The isolation resistance is then calculated as $R=V / I$. In the following procedure, the Model 617 functions as both a voltage source and an ammeter. In the V/I function, the Model 617 internally calculates the resistance from the known voltage and current levels and displays the resistive value.

Perform the following steps to check bank and chan-nel-to-channel isolation:

1. Turn the Model 7001 off if it is on, and remove any jumpers or test leads connected to the multiplexer card.
2. Turn on the Model 617 and allow the unit to warm up for two hours before testing.
3. On the Model 617, select the 2pA range, and enable zero check and zero correct in that order. Leave zero correct enabled for the entire procedure.
4. Connect the electrometer to the Model 7011, as shown in Figure 5-4.
5. Install the Model 7011 in slot 1 (CARD 1) of the Model 7001 and turn the mainframe on.
6. On the Model 617 , select the 20 pA range and release zero check.
7. On the Model 617, press SUPPRESS to cancel offset current, then enable zero check.

## WARNING

The following steps use high voltage (100V). Be sure to remove power from the circuit before making connection changes.
8. On the Model 617 , set the voltage source for +100 V , and select the 20 nA current range. Make sure the voltage source is in standby.
9. Place the Model 617 in the V/I measurement function by pressing SHIFT OHMS.
10. Program the Model 7001 to close Channels $1!1$ and $1!12$ (Bank A, Input 1 and Bank B, Input 2).


Figure 5-4
Bank isolation test connections
11. On the Model 617, disable zero check and press OPERATE to source +100 V .
12. After allowing the reading on the Model 617 to settle, verify that it is $>1 G \Omega\left(10^{9} \Omega\right)$. This measurement is the leakage resistance (bank isolation) between Bank A, Input 1 and Bank B, Input 2.
13. Place the Model 617 voltage source in standby and enable zero check.
14. Turn off the Model 7001 and move the electrometer connections to Banks B and C.
15. Install the Model 7011 in slot 1 of the mainframe and turn the Model 7001 on.
16. Program the Model 7001 to close Channels $1!12$ and 1!23 (Bank B, Input 2 and Bank C, Input 3).
17. On the Model 617, disable zero check and press OPERATE to source +100 V .
18. After allowing the reading on the Model 617 to settle, verify that it is $>1 G \Omega\left(10^{9} \Omega\right)$.
19. Place the Model 617 voltage source in standby and enable zero check.
20. Turn off the Model 7001 and move the electrometer connections to Banks C and D.
21. Install the Model 7011 in slot 1 of the mainframe, and turn the Model 7001 on.
22. Using Table 5-2 as a guide, repeat the basic procedure of steps 16 through 18 for the rest of the path pairs (test numbers 3 through 9 in the table).
23. Place the Model 617 voltage source in standby and enable zero check.

## NOTE

Refer to for the following procedure to check channel-to-channel isolation.
24. Turn off the Model 7001 and connect the Model 617 to the card as shown in Figure 5-5.
25. Install the Model 7011 in slot 1 of the Model 7001, and turn the mainframe on.
26. Program the Model 7001 to close Channel $1!2$ (Bank A, Input 2). Make sure all other channels are open.
27. On the Model 617, disable zero check and press OPERATE to source 100 V .
28. After allowing the reading on the Model 617 to setthe, verify that it is $>1 \mathrm{G} \Omega\left(10^{9} \Omega\right)$.
29. Place the Model 617 voltage source in standby, and enable zero check.
30. Using Table 5-3 as a guide, perform tests 2 through 9 for the remaining Bank A Inputs. Remember to move Bank Input connections as indicated in the table.
31. Use Table 5-3 (test numbers 10 through 36) and the above procedure to test Banks B, C, and D.

Table 5-2
Bank isolation test summary

| Test <br> number | Bank isolation | Test equipment location | Channels closed ${ }^{*}$ |
| :---: | :--- | :--- | :--- |
| 1 | Bank A, Input 1 to Bank B, Input 2 | Bank A and Bank B | $1!1$ and $1!12$ |
| 2 | Bank B, Input 2 to Bank C, Input 3 | Bank B and Bank C | $1!12$ and $1!23$ |
| 3 | Bank C, Input 3 to Bank D, Input 4 | Bank C and Bank D | $1!23$ and $1!34$ |
| 4 | Bank C, Input 4 to Bank D, Input 5 | Bank C and Bank D | $1!24$ and $1!35$ |
| 5 | Bank C, Input 5 to Bank D, Input 6 | Bank C and Bank D | $1!25$ and $1!36$ |
| 6 | Bank C, Input 6 to Bank D, Input 7 | Bank C and Bank D | $1!26$ and $1!37$ |
| 7 | Bank C, Input 7 to Bank D, Input 8 | Bank C and Bank D | $1!27$ and $1!38$ |
| 8 | Bank C, Input 8 to Bank D, Input 9 | Bank C and Bank D | $1!28$ and $1!39$ |
| 9 | Bank C, Input 9 to Bank D, Input 10 | Bank C and Bank D | $1!29$ and $1!40$ |

[^0]

Figure 5-5
Channel-to-channel isolation test connections

Table 5-3
Channel-to-channel isolation test summary

| Test number | Channel-to-channel isolation | Test equipment location | Channel closed* |
| :---: | :---: | :---: | :---: |
| 1 | Bank A, Input 1 to Bank A, Input 2 | Bank A and Input 1 | $1!2$ |
| 2 | Bank A, Input 2 to Bank A, Input 3 | Bank A and Input 2 | $1!3$ |
| 3 | Bank A, Input 3 to Bank A, Input 4 | Bank $A$ and Input 3 | $1!4$ |
| 4 | Bank A, Input 4 to Bank A, Input 5 | Bank $A$ and Input 4 | 115 |
| 5 | Bank A, Input 5 to Bank A, Input 6 | Bank $A$ and Input 5 | $1!6$ |
| 6 | Bank A, Input 6 to Bank A, Input 7 | Bank $A$ and Input 6 | 117 |
| 7 | Bank A, Input 7 to Bank A, Input 8 | Bank $A$ and Input 7 | $1!8$ |
| 8 | Bank A, Input 8 to Bank A, Input 9 | Bank $A$ and Input 8 | $1!9$ |
| 9 | Bank A, Input 9 to Bank A, Input 10 | Bank $A$ and Input 9 | $1!10$ |
| 10 | Bank B, Input 1 to Bank B, Input 2 | Bank $B$ and Input 1 | 1112 |
| 11 | Bank B, Input 2 to Bank B, Input 3 | Bank B and Input 2 | 1113 |
| 12 | Bank B, Input 3 to Bank B, Input 4 | Bank $B$ and Input 3 | $1!14$ |
| 13 | Bank B, Input 4 to Bank B, Input 5 | Bank B and Input 4 | 1115 |
| 14 | Bank B, Input 5 to Bank B, Input 6 | Bank B and Input 5 | $1!16$ |
| 15 | Bank B, Input 6 to Bank B, Input 7 | Bank $B$ and Input 6 | 1117 |
| 16 | Bank B, Input 7 to Bank B, Input 8 | Bank B and Input 7 | 1118 |
| 17 | Bank B, Input 8 to Bank B, Input 9 | Bank B and Input 8 | 1119 |
| 18 | Bank B, Input 9 to Bank B, Input 10 | Bank $B$ and Input 9 | 1!20 |
| 19 | Bank C, Input 1 to Bank C, Input 2 | Bank C and Input 1 | $1!22$ |
| 20 | Bank C, Input 2 to Bank C, Input 3 | Bank C and Input 2 | 1!23 |
| 21 | Bank C, Input 3 to Bank C, Input 4 | Bank C and Input 3 | $1!24$ |
| 22 | Bank C, Input 4 to Bank C, Input 5 | Bank C and Input 4 | $1!25$ |
| 23 | Bank C, Input 5 to Bank C, Input 6 | Bank $C$ and Input 5 | $1!26$ |
| 24 | Bank C, Input 6 to Bank C, Input 7 | Bank $C$ and Input 6 | $1!27$ |
| 25 | Bank C, Input 7 to Bank C, Input 8 | Bank $C$ and Input 7 | $1!28$ |
| 26 | Bank C, Input 8 to Bank C, Input 9 | Bank C and Input 8 | $1!29$ |
| 27 | Bank C, Input 9 to Bank C, Input 10 | Bank $C$ and Input 9 | 1!30 |
| 28 | Bank D, Input 1 to Bank D, Input 2 | Bank D and Input 1 | $1!32$ |
| 29 | Bank D, Input 2 to Bank D, Input 3 | Bank D and Input 2 | $1!33$ |
| 30 | Bank D, Input 3 to Bank D, Input 4 | Bank D and Input 3 | 1134 |
| 31 | Bank D, Input 4 to Bank D, Input 5 | Bank D and Input 4 | 1135 |
| 32 | Bank D, Input 5 to Bank D, Input 6 | Bank D and Input 5 | 1136 |
| 33 | Bank D, Input 6 to Bank D, Input 7 | Bank D and Input 6 | 1137 |
| 34 | Bank D, Input 7 to Bank D, Input 8 | Bank D and Input 7 | 1138 |
| 35 | Bank D, Input 8 to Bank D, Input 9 | Bank D and Input 8 | 1139 |
| 36 | Bank D, Input 9 to Bank D, Input 10 | Bank D and Input 9 | $1!40$ |

*Assumes Model 7011 installed in slot 1 of mainframe. Programmed as slot (1) and channel.

### 5.3.8 Differential and common-mode isolation tests

These tests check the leakage resistance (isolation) between $\mathrm{HI}(\mathrm{H})$ and LO ( L ) (differential), and from $\mathrm{HI}(\mathrm{H})$ and LO (L) to chassis (common-mode) of every bank and channel. In general, the test is performed by applying a voltage ( 100 V ) across the terminals and then measuring the leakage current. The isolation resistance is then calculated as $\mathrm{R}=\mathrm{V} / \mathrm{I}$. In the following procedure, the Model 617 functions as a voltage source and an ammeter. In the V/I function, the Model 617 internally calculates the resistance from the known voltage and current levels, and displays the resistance value.
erform the following steps to check differential and ommon mode isolation:

1. Turn the Model 7001 off if it is on, and remove any jumpers and test leads connected to the multiplexer card.
2. Turn on the Model 617 and allow the unit to warm up for two hours for rated accuracy.
3. On the Model 617 , select the 2pA range, and enable zero check and zero correct in that order. Leave zero correct enabled for the entire procedure.

## WARNING

The following steps use high voltage (100V). Be sure to remove power from the circuit before making connection changes.
4. On the Model 617 , set the voltage source for +100 V , and select the 200 nA current range. Make sure the voltage source is still in standby.
5. Place the Model 617 in the $\mathrm{V} / \mathrm{I}$ measurement function by pressing SHIFT OHMS.
6. With the Model 617 in standby, connect the electrometer to Bank A of the multiplexer card, as shown in Figure 5-6.
7. Install the Model 7011 in slot 1 (CARD 1) of the mainframe, and turn the Model 7001 on.
8. Make sure all the relays are open. (Press OPEN ALL on the Model 7001.)
9. On the Model 617, disable zero check, and press OPERATE to source 100 V .
10. After allowing the reading on the Model 617 to settle, verify that it is $>1 \mathrm{G} \Omega\left(10^{9} \Omega\right)$. This measurement is the differential leakage resistance (isolation) of Bank A.
11. Place the Model 617 in standby and enable zero check.


Figure 5-6
Differential isolation test connections
12. Program the Model 7001 to close Channel $1!1$ (Bank A, Input 1).
13. On the Model 617, disable zero check and press OPERATE to source +100 V .
14. After allowing the reading on the Model 617 to settle, verify that it is also $>1 \mathrm{G} \Omega\left(10^{9} \Omega\right)$. This measurement checks the differential isolation of Input 1.
15. Using Table 5-4 as a guide, repeat the basic procedure in steps 11 through 14 to test Inputs 2 through 10 of Bank A (test numbers 3 through 11 of the table).
16. Use Table 5-4 (test numbers 12 through 42) and the above procedure to test Banks B, C and D.
17. Place the Model 617 voltage source in standby and enable zero check.

## NOTE

Refer to Figure 5-7 for the following procedure to check common mode isolation.
18. Turn off the Model 7001, and connect the electrometer to the Model 7011 as shown in Figure 5-7.
19. Repeat steps 4 through 16 to check common mode isolation. Verify that each reading is $>1 \mathrm{G} \Omega\left(10^{9} \Omega\right)$.

Table 5-4
Differential and common-mode isolation testing

| Test number | Differential or common mode isolation | Channel closed* |
| :---: | :---: | :---: |
| 1 | Bank A | None |
| 2 | Bank A, Input 1 | $1!1$ |
| 3 | Bank A, Input 2 | $1!2$ |
| 4 | Bank A, Input 3 | 113 |
| 5 | Bank A, Input 4 | 114 |
| 6 | Bank A, Input 5 | 115 |
| 7 | Bank A, Input 6 | 116 |
| 8 | Bank A, Input 7 | $1!7$ |
| 9 | Bank A, Input 8 | 118 |
| 10 | Bank A, Input 9 | 119 |
| 11 | Bank A, Input 10 | $1!10$ |
| 12 | Bank B | None |
| 13 | Bank B, Input 1 | 1111 |
| 14 | Bank B, Input 2 | 1112 |
| 15 | Bank B, Input 3 | $1!13$ |
| 16 | Bank B, Input 4 | 1114 |
| 17 | Bank B, Input 5 | $1!15$ |
| 18 | Bank B, Input 6 | $1!16$ |
| 19 | Bank B, Input 7 | 1117 |
| 20 | Bank B, Input 8 | $1!18$ |
| 21 | Bank B, Input 9 | 1119 |
| 22 | Bank B, Input 10 | $1!20$ |
| 23 | Bank C | None |
| 24 | Bank C, Input 1 | $1!21$ |
| 25 | Bank C, Input 2 | $1!22$ |
| 26 | Bank C, Input 3 | 1123 |
| 27 | Bank C, Input 4 | $1!24$ |
| 28 | Bank C, Input 5 | $1!25$ |
| 29 | Bank C, Input 6 | $1!26$ |
| 30 | Bank C, Input 7 | $1!27$ |
| 31 | Bank C, Input 8 | $1!28$ |
| 32 | Bank C, Input 9 | $1!29$ |
| 33 | Bank C, Input 10 | 1130 |
| 34 | Bank D | None |
| 35 | Bank D, Input 1 | $1!31$ |
| 36 | Bank D, Input 2 | 1132 |
| 37 | Bank D, Input 3 | 1133 |
| 38 | Bank D, Input 4 | 1134 |
| 39 | Bank D, Input 5 | 1135 |
| 40 | Bank D, Input 6 | 1136 |
| 41 | Bank D, Input 7 | 1137 |
| 42 | Bank D, Input 8 | 1138 |
| 43 | Bank D, Input 9 | 1139 |
| 44 | Bank D, Input 10 | 1140 |

*Assumes Model 7011 installed in slot 1 of mainframe. Programmed as slot (1) and channel.


Figure 5-7
Common-mode isolation test connections

### 5.4 Special handling of static-sensitive devices

CMOS and other high-impedance devices are subject to possible static discharge damage because of the high-impedance levels involved. When handling such devices, use the precautions listed below.

## NOTE

In order to prevent damage, assume that all parts are static-sensitive.

1. Such devices should be transported and handled only in containers specially designed to prevent or dissipate static build-up. Typically, these devices will be received in anti-static containers made of plastic or foam. Keep these parts in their original containers until ready for installation or use.
2. Remove the devices from their protective containers only at a properly-grounded workstation. Also, ground yourself with an appropriate wrist strap while working with these devices.
3. Handle the devices only by the body; do not touch the pins or terminals.
4. Any printed circuit board into which the device is to be inserted must first be grounded to the bench or table.
5. Use only anti-static type de-soldering tools and grounded-tip soldering irons.

### 5.5 Principles of operation

The following paragraphs discuss the basic operating principles for the Model 7011, and can be used as an aid in troubleshooting the card. The schematic drawing of the card is shown on drawing number 7011-106, located at the end of Section 6.

### 5.5.1 Block diagram

Figure 5-8 shows a simplified block diagram of the Model 7011. Key elements include the relay drivers and relays, as well as the ROM, which contains card ID and configuration information. These various elements are discussed in the following paragraphs.

### 5.5.2 ID data circuits

Upon power-up, card identification information from each card is read by the mainframe. This ID data includes such information as card ID, hardware settling time, and relay configuration information.

ID data is contained within an on-card EEPROM (U105). In order to read this information, the sequence described below is performed on power-up.

1. The IDDATA line (pin 6 of U 105 ) is set from high to low while the IDCLK line (pin 5 of U105) is held high. This action initiates a start command to the ROM to transmit data serially to the mainframe (Figure 5-9).
2. The mainframe sends the ROM address location to be read over the IDDATA line. The ROM then transmits an acknowledge signal back to the mainframe, and it then transmits data at that location back to the mainframe (Figure 5-10).
3. The mainframe then transmits an acknowledge signal, indicating that it requires more data. The ROM will then sequentially transmit data after each acknowledge signal it receives.
4. Once all data is received, the mainframe sends a stop command, which is a low-to-high transition of the IDDATA line with the IDCLK line held high (see Figure 5-9).


Figure 5-8
Model 7011 block diagram


Figure 5-9
Start and stop sequences


Figure 5-10
Transmit and acknowledge sequence

### 5.5.3 Relay control

Card relays are controlled by serial data transmitted via the relay DATA line. A total of five bytes for each card are shifted in serial fashion into latches located in the card relay driver ICs. The serial data is clocked in by the CLK line. As data overflows one register, it is fed out the Q'S line of the register down the chain.

Once all five bytes have shifted into the card, the STROBE line is set high to latch the relay information into the $Q$ outputs of the relay drivers, and the appropriate relays are energized (assuming the driver outputs are enabled, as discussed below). Note that a relay driver output goes low to energize the corresponding relay.

### 5.5.4 Relay power control

A relay power control circuit, made up of U106, U107, Q100, Q101, and associated components, keeps power dissipated in relay coils at a minimum, thus reducing possible problems caused by thermal EMFs.

During steady-state operation, the relay supply voltage, +V , is regulated to +3.5 V to minimize coil power dissipation. When a relay is first closed, the STROBE pulse applied to U106 changes the parameters of the relay supply voltage regulator, Q 100 , allowing the relay supply voltage, +V , to rise to +5.7 V for about 100 msec . This brief voltage rise ensures that relays close as quickly as possible. After the 100 msec period has elapsed, the relay supply voltage ( +V ) drops back down to its nominal steady-state value of +3.5 V .

### 5.5.5 Power-on safeguard

## NOTE

The power-on safeguard circuit discussed below is actually located on the digital board in the Model 7001 mainframe.

A power-on safeguard circuit, made up of U114 (a Dtype flip-flop) and associated components ensures that relays do not randomly energize on power-up and power-down. This circuit disables all relays (all relays are open) during power-up and power-down periods.

The PRESET line on the D-type flip-flop is controlied by the 68302 microprocessor, while the CLK line of the D-type flip-flop is controlled by a VIA port line on the 68302 processor. The Q output of the flip-flop drives each switch card relay driver IC enable pin (U100U104, pin 8).

When the 68302 microprocessor is in the reset mode, the flip-flop PRESET line is held low, and Q out immediately goes high, disabling all relays (relay driver IC enable pins are high, disabling the relays). After the reset condition elapses ( $\approx 200 \mathrm{msec}$ ), PRESET goes high while $Q$ out stays high. When the first valid STROBE pulse occurs, a low logic level is clocked into the Dtype flip-flop, setting Q out low and enabling all relay drivers simultaneously. Note that $Q$ out stays low, (enabling relay drivers) until the 68302 processor goes into a reset condition.

### 5.6 Troubleshooting

### 5.6.1 Troubleshooting equipment

Table 5-5 summarizes recommended equipment for troubleshooting the Model 7011.

Table 5-5
Recommended troubleshooting equipment

| Description | Manufacturer <br> and model | Application |
| :--- | :--- | :--- |
| Multimeter | Keithley 196 | Measure DC voltages |
| Oscilloscope | TEK 2243 | View logic waveforms |

### 5.6.2 Troubleshooting access

In order to gain access to the relay card top surface to measure voltages under actual operation conditions, perform the following steps:

1. Disconnect the connector card from the relay card.
2. Remove the Model 7001 cover.
3. Install the relay card in the CARD 1 slot location.
4. Turn on Model 7001 power to measure voltages (see following paragraph).

### 5.6.3 Troubleshooting Procedure

Table 5-6 summarizes switch card troubleshooting.

## WARNING

Lethal voltages are present within the 7001 mainframe. Some of the procedures may expose you to hazardous voltages. Observe standard safety precautions for dealing with live circuits. Failure to do so could result in personal injury or death.

## CAUTION

Observe the following precautions when troubleshooting or repairing the switch card:

To avoid contamination, which could degrade card performance, always handle the card only by the handle and side edges. Do not touch edge connectors, board surfaces, or components on the card. Also, do not touch areas adjacent to electrical contacts on corunectors.

Use care when removing relays from the PC board to avoid pulling traces away from the circuit board. Before attempting to remove a relay, use an appropriate de-soldering tool, such as a solder sucker, to clear each mounting hole completely free of solder. Each relay pin must be free to move in its mounting hole before removal. Also, make certain that no burrs are present on the ends of the relay pins.

Table 5-6
Troubleshooting procedure

| Step | Item/component | Required condition | Comments |
| :---: | :--- | :--- | :--- |
| 1 | GND pad |  | All voltages referenced to digital ground <br> (GND pad). <br> 2 |
| 3 | +6 V pad | +5 V pad | Relay voltage. |
| 4 | +14.6 V pad | +5 VDC | Logic voltage. |
| 5 | +V pad | +14.6 VDC | Relay bias voltage. |
| 6 | U105, pin 5 | +3.5 VDC | Regulated relay voltage. |
| 7 | U105, pin 6 | ID CLK pulses | During power-up only. |
| 8 | U100, pin 7 | U100, pin 2 DATA pulses | STROBE pulse |
| 9 | U100, pin 3 | CLK pulses | End of relay update sequence. |
| 11 | U100-U104, pins 10-18 | Low with relay energized; | During relay update sequence only. |

${ }^{*}+3.5 \mathrm{VDC}$ present at +V pad under steady-state conditions. This voltage rises to +5.7 VDC for about 100 msec when relay configuration is changed.

## Replaceable Parts

### 6.1 Introduction

This section contains replacement parts information, schematic diagrams, and component layout drawings for the Model 7011.

### 6.2 Parts lists

Parts lists for the various circuit boards are included in tables integrated with schematic diagrams and component layout drawings for the boards. Parts are listed alphabetically in order of circuit designation.

### 6.3 Ordering information

To place an order, or to obtain information concerning replacement parts, contact your Keithley representative or the factory (see inside front cover for addresses). When ordering parts, be sure to include the following information:

1. Card model number 7011
2. Card serial number
3. Part description
4. Circuit description, if applicable
5. Keithley part number

### 6.4 Factory service

If the card is to be returned to Keithley Instruments for repair, perform the following:

1. Complete the service form at the back of this manual and include it with the card.
2. Carefully pack the card in the original packing carton.
3. Write ATTENTION REPAIR DEPT on the shipping label.

Note: It is not necessary to return the matrix mainframe with the card.

### 6.5 Component layouts and schematic diagrams

Component layout drawings and schematic diagrams are included on the following pages integrated with the parts lists:

Table 1 Parts List, Relay Card for 7011-S and 7011-C. 7011-100 Component Layout, Relay Card for 7011-S and 7011-C.
7011-106 Schematic, Relay Card for 7011-S and 7011C.

## NOTE

The Model 7011 and 7012 use the same relay card, only the connector cards are different.

Table 2 Parts List, Screw Terminated Connector Card for 7011-S.
7011-160 Component Layout, Screw Terminated Connector Card for 7011-S.
7011-166 Schematic, Screw Terminated Connector Card for 7011-S.

Table 3 Parts List, Mass Terminated Connector Card for 7011-C.
7011-170 Component Layout, Mass Terminated Connector Card for 7011-C.
7011-176 Schematic, Mass Terminated Connector Card for 7011-C.

Table 6-1
Relay Board for Model 7011-S and 7011-C, Parts List

| Circuit Desig. | Description | Keithley <br> Part No. |
| :---: | :---: | :---: |
|  | EJECTOR ARM | 7011-301 |
|  | ROLL PIN (FOR EJECTOR ARMS) | DP-6-1 |
|  | SHIELD | 7011-305 |
|  | SOCKET (FOR U105) | SO-72 |
| C100-109,118,119 | CAP,.1UF,20\%,50V,CERAMIC | C-365.1 |
| C110,111 | CAP,1UF,20\%,50V,CERAMC | C-237-1 |
| C112 | CAP,0.001UF,20\%,500V,CERAMIC | C-22-. 001 |
| C113,114 | CAP,10UF,-20+100\%,25V,ALUM ELEC | C-314-10 |
| C115-117 | CAP,150PF,10\%,1000V,CERAMIC | C-64-150P |
| J1002,1003 | CONNECTOR, MALE | CS-736-2 |
| K100-139 | RELAY, ULTRA-SMALL POLARIZED TF2E-5V | RL-149 |
| P2001 | CONNECTOR, RIGHT ANGLE MALE | CS-775-1 |
| Q100 | TRANS, NPN PWR, TIP31, (TO-220AB) | TG-253 |
| Q101 | TRANS,N CHAN MOSPOW FET,V11713 (TO-92) | TG-195 |
| R100 | RES, $2.49 \mathrm{~K}, 1 \%, 1 / 8 \mathrm{~W}, \mathrm{METAL}$ FILM | R-88-2.49K |
| R101 | RES, $1.15 \mathrm{~K}, 1 \%, 1 / 8 \mathrm{~W}, \mathrm{METAL}$ FILM | R-88-1.15K |
| R102,103 | RES, $560,10 \%, 1 / 2 \mathrm{~W}, \mathrm{COMPOSITION}$ | R-1-560 |
| R104 | RES,1K,1\%,1/8W,METAL FILM | R-88-1K |
| R105 | RES,220K, $5 \%, 1 / 4 \mathrm{~W}, \mathrm{COMPOSITION} \mathrm{OR} \mathrm{FILM}$ | R-76-220K |
| R106,107 | RES,10K,5\%,1/4W,COMPOSITION OR FILM | R-76-10K |
| U100-104 | IC, 8-BIT SERIAL-IN LATCH DRIVER, 5841A. | IC-536 |
| U105 | EPROM PROGRAM | 7011-800-*** |
| U106 | IC,RETRIG MONO MULTTVIB,74HC123 | IC-492 |
| U107 | IC,AJD SHUNT REGULATOR,TLA31CLP | IC-677 |
| W100-107 | JUMPER | J-15 |

***Order current firmware revision level.




Table 6-2
Screw Terminal Board for Model 7011-S, Parts List

| Circuit <br> Desig. | Description | Keithley <br> Part No. |
| :--- | :--- | :--- |
|  | CABLE CLAMP <br> CAPTIVE SCREW (FOR TOP CLAMP) <br> CONNECTOR, JUMPER (FOR CS-339-2) <br> CONNECTOR SHIM (FOR P1002, 1003) <br> SHIELD <br> STRIP, POLYURETHANE (FOR BOTTOM CLAMP) <br> TOP CLAMP | $7011-304-1$ <br> FA-243-1 <br> CS-476 <br> $7011-309$ |
| $1004,1005,1007$   <br> $1008,1010,1011, ~$ CONN, 8 PIN $7011-305$ <br> 1013,1014   <br> J1006,1009,1012, CONN, 6-PIN $7011-345-1$ |  |  |
| 1015 | CONNECTOR, 48-PIN, 3 ROWS |  |
| P1002,1003 | CONN,BERG, 2 PIN | TE-115-8 |
| W100-105 |  | TE-115-6 |




Table 6-3
Mass Terminated Connector Board for Model 7011-C, Parts List

| Circuit Desig. | Description | Keithley <br> Part No. |
| :---: | :---: | :---: |
|  | BRACKET | 7011-307 |
|  | STANDOFF | ST-203-1 |
|  | SHIELD | 7011-311 |
|  | CONNECTOR SHIIM | 7011-309 |
|  | CONN,BERG | CS-339 |
|  | CONNECTOR, JUMPER (FOR W100-105) | CS-476 |
| C101,102 | CAP,1UF,20\%,50V, CERAMIC | C-237-1 |
| C103 | CAP,.1UF,20\%,50V,CERAMIC | C-365-. 1 |
| CR101-105 | DIODE,SILICON,IN4148 (DO-35) | RF-28 |
| E101,102 | FERRITE BEAD | CT-8 |
| J1004 | CONN, $96-\mathrm{PIN}, 3$ ROWS | CS-514 |
| K101-104 | RLAY, ULTRA-SMALL POLARIZED TF2E-4.5V | RL-162 |
| P1002,1003 | CONNECTOR, FEMALE | CS-748-3 |
| Q101-103 | TRANS, N CHAN MOSPOW FET, V11713 (TO-92) | TG-195 |
| R103,104 | RES, $1 \mathrm{M}, 10 \%, 1 / 2 \mathrm{~W}, ~ C O M P O S I T I O N ~$ | R-1-1M |
| R105 | RES, $39,5 \%, 1 / 4 \mathrm{~W}, \mathrm{COMPOSITION}$ OR FILM | R-76-39 |
| R106 | RES, $10,5 \%, 1 / 4 W$, COMPOSITION OR FILM | R-76-10 |
| R107 | RES,4.99K,1\%,1/8W,METAL FILM | R-88-4.99K |
| R108,110 | RES,10K,5\%,1/4W,COMPOSITION OR FILM | R-76-10K |
| R109 | RES,100K, $5 \%, 1 / 4 W$ COMPOSITION OR FILM | R-76-100K |
| R111 | RES,10K,1\%,1/8W,METAL FILM | R-88-10K |
| U101 | IC,QUAD 2 INPUT NOR,74HC02 | IC-412 |
| U102 | IC, DUAL COMP,LM393 | IC-343 |
| W100-105 | CONN, BERG, 2 PIN | CS-339-2 |




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[^0]:    *Assumes Model 7011 installed in slot 1 of mainframe. Programmed as slot (1) and channel.

